

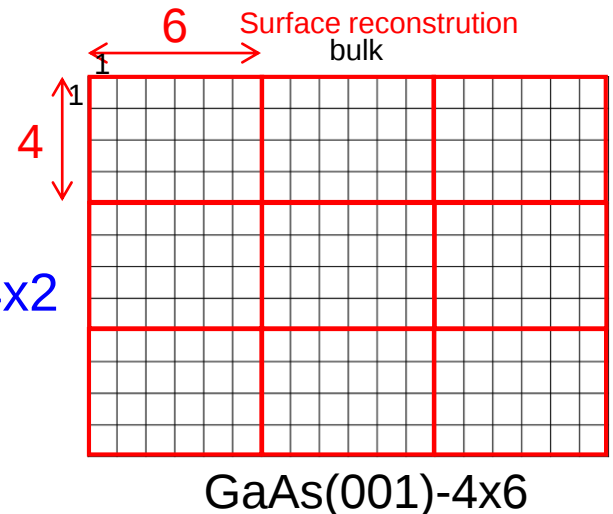
Oxide/(In)GaAs interfacial electronic characteristics by *in-situ* synchrotron radiation photoemission (SRPES)

陳婉馨

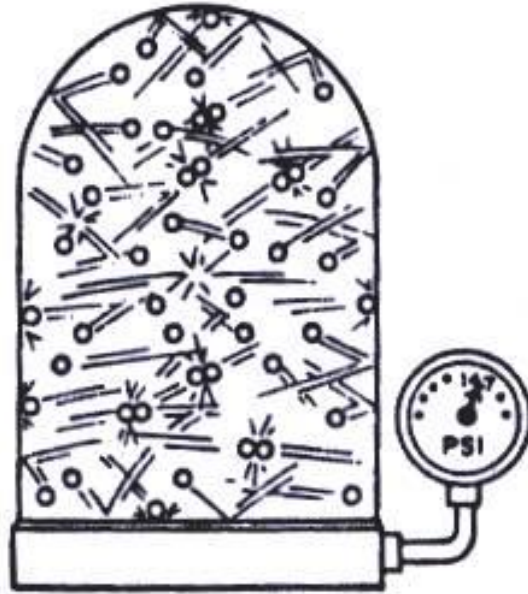
2018/10/04

Outline

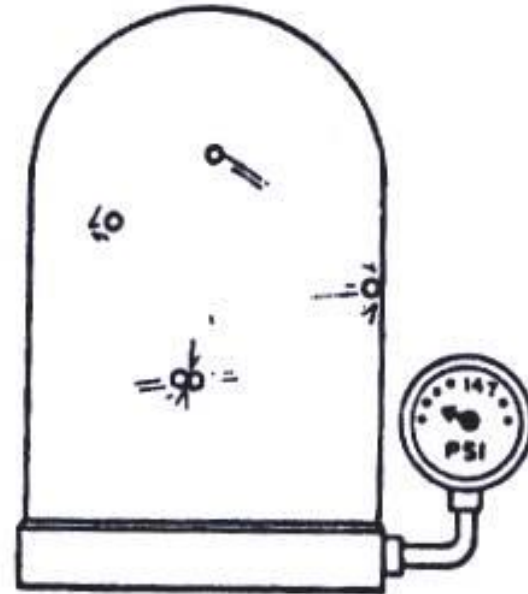
- Why ultra-high vacuum (UHV)?
 - all UHV process from growth to measurement
- Motivation
 - ALD/MBE high-k/(In)GaAs interfaces with excellent CVs
- Experimental
 - sample growth in an integrated MBE/ALD system
 - *in-situ* synchrotron radiation photoemission (SRPES)
- Initial growth mechanism
 - ALD $\text{Y}_2\text{O}_3/\text{GaAs}(001)$ -4x6
 - MBE Y_2O_3 or $\text{HfO}_2/\text{GaAs}(001)$ -4x6
 - MBE Y_2O_3 or $\text{HfO}_2/\text{In}_{0.53}\text{Ga}_{0.47}\text{As}(001)$ -4x2



What is vacuum?



(a)大氣



(b)真空

壓力 < 大氣壓力

圖 1.5 大氣與真空狀態下之分子數目

Definition of Vacuum

Atmosphere	1 atm = 760 torr
Rough (low) vacuum	$759 - 10^{-3}$ torr
Medium vacuum	$10^{-3} - 10^{-5}$ torr
High vacuum (HV)	$10^{-5} - 10^{-8}$ torr
Ultra high vacuum (UHV)	$< 10^{-8}$ torr

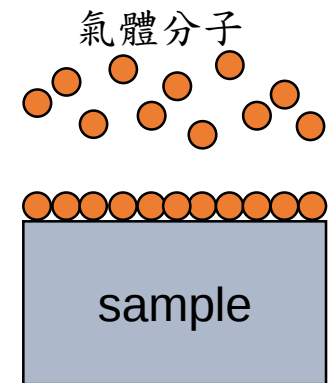
壓力大小與殘留氣體負荷

壓力 (torr)	主要氣體負荷
760	N ₂ (約為78%)
10^{-3}	H ₂ O (約為75%)
10^{-6}	H ₂ O, CO
10^{-9}	H ₂ , CO
10^{-10}	H ₂ , CO
10^{-11}	H ₂

Why ultra-high vacuum (UHV)?

壓力與單層膜形成時間之關係

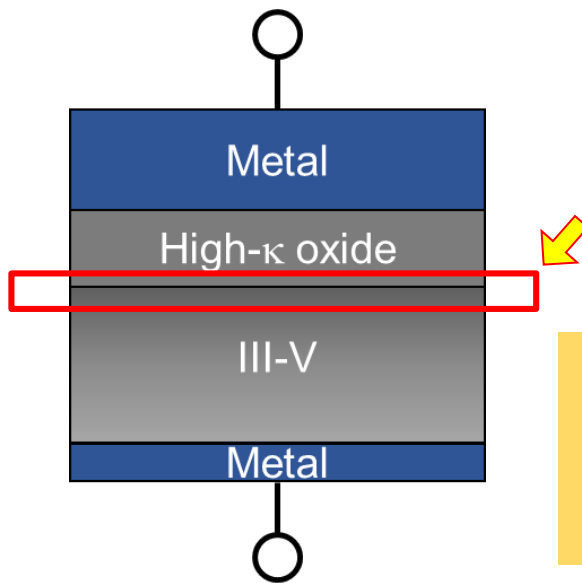
壓力 (torr)	單層膜形成時間 (sec)
10^{-6}	1
10^{-7}	10
10^{-8}	100
10^{-9}	1000



The characterization of a solid surface on an atomic level implies unambiguously that the surface composition **remains essentially unchanged** over the duration of an experiment.

MBE-oxide/III-V interface

- ✓ *Excellent CV characteristics*
- ✓ *High thermal stability to **900 °C***
- ✓ *Low $D_{it} \sim (2-5) \times 10^{11} \text{ eV}^{-1} \text{ cm}^{-2}$ without peak in the mid-gap*



In-situ
synchrotron radiation photoemission (SRPES)

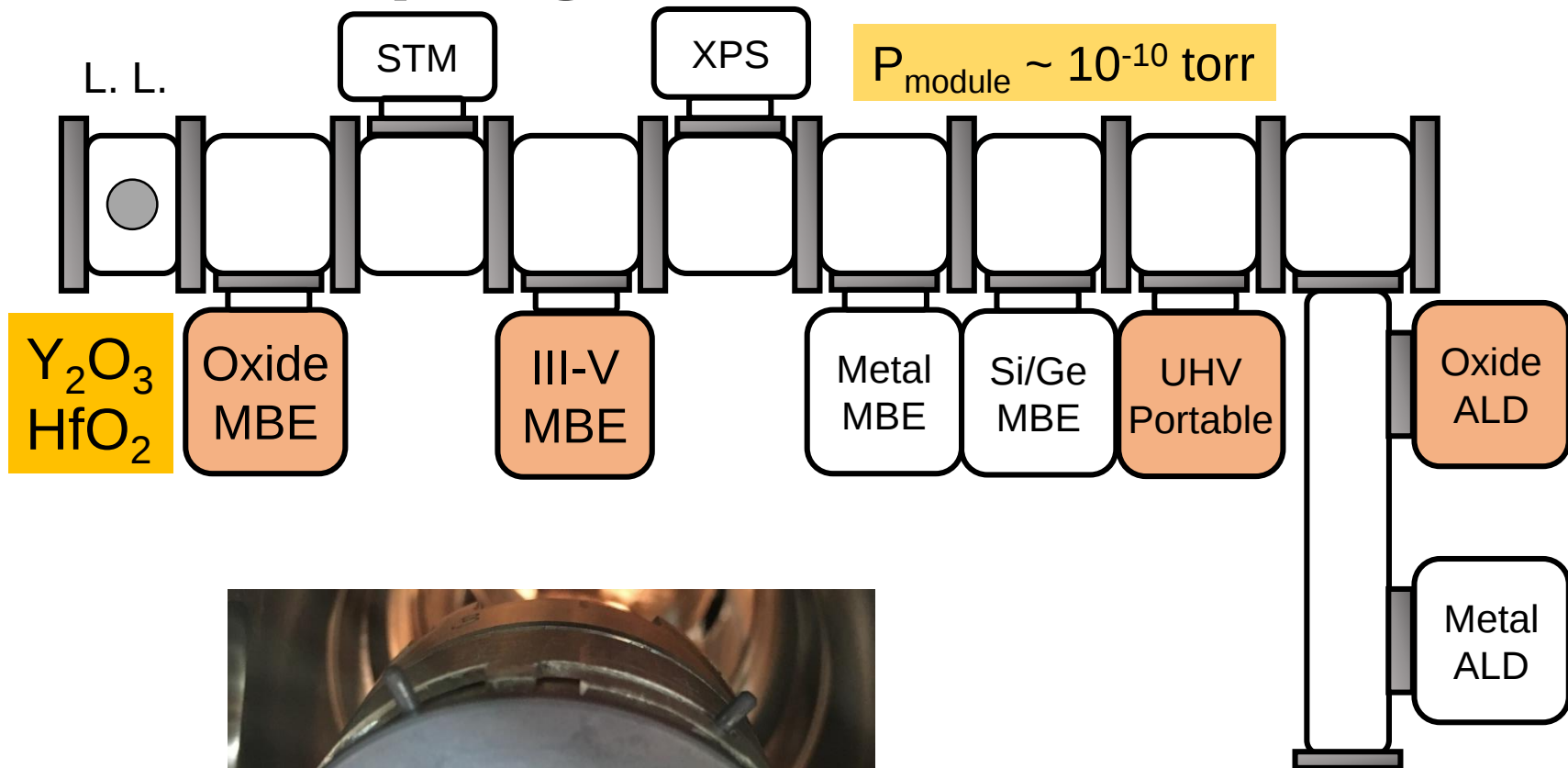
SRPES

- high surface sensitivity ($\lambda = 4 \text{ \AA}$)
- high energy resolution (**< 40 meV**)

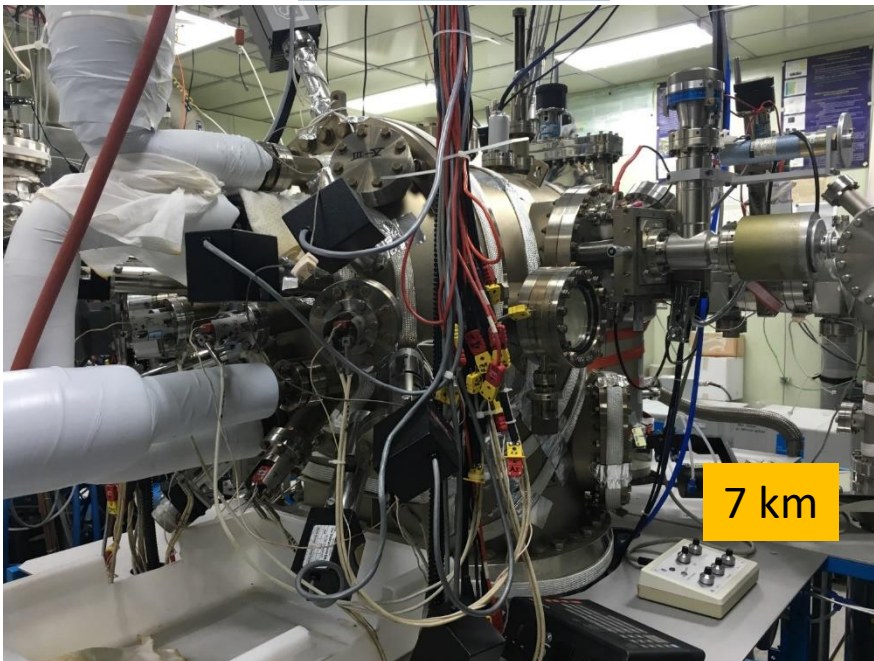
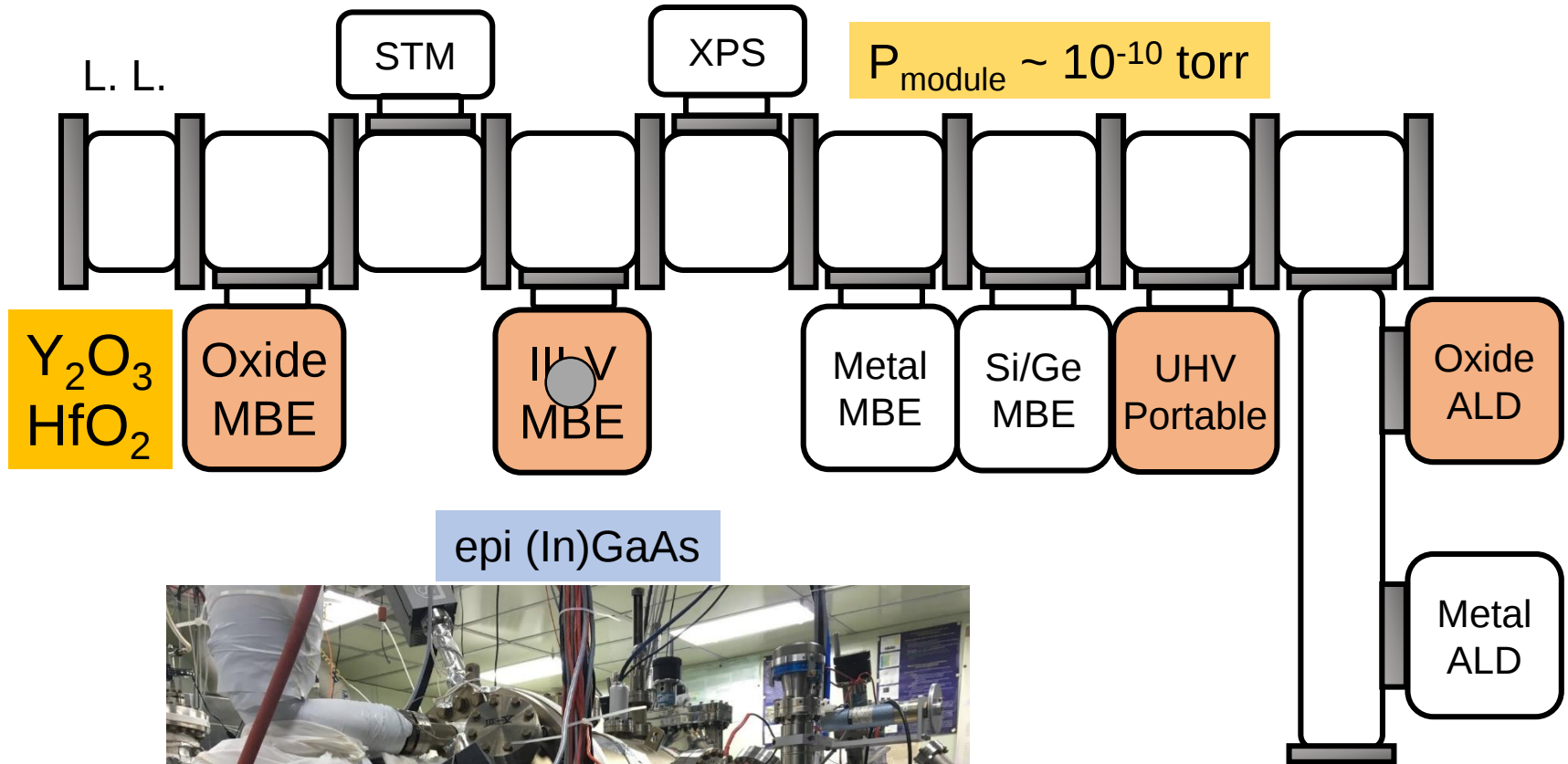
MOSCAP

➤ **SRPES**: direct observation of interfacial electronic structure

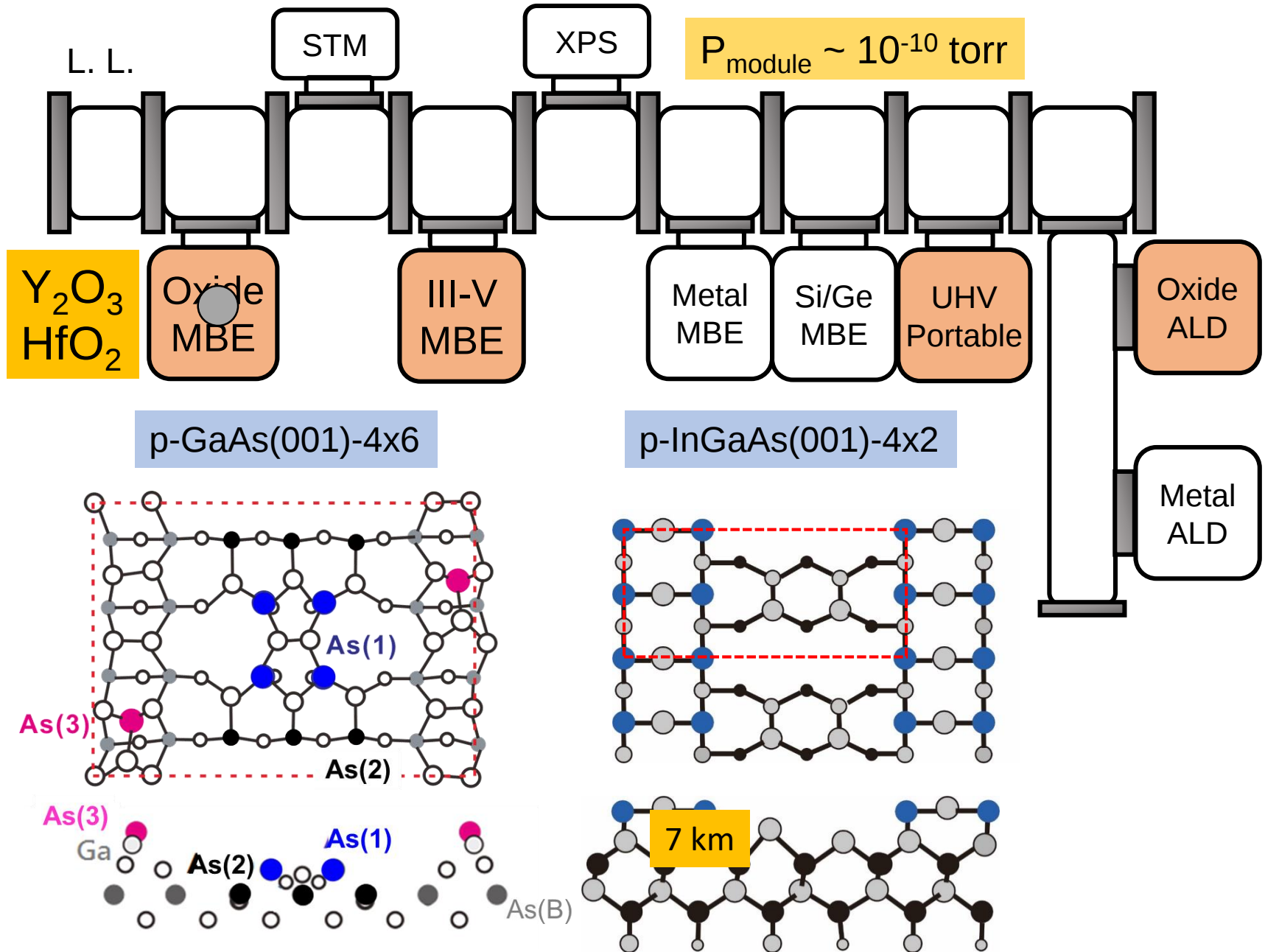
sample growth and transfer



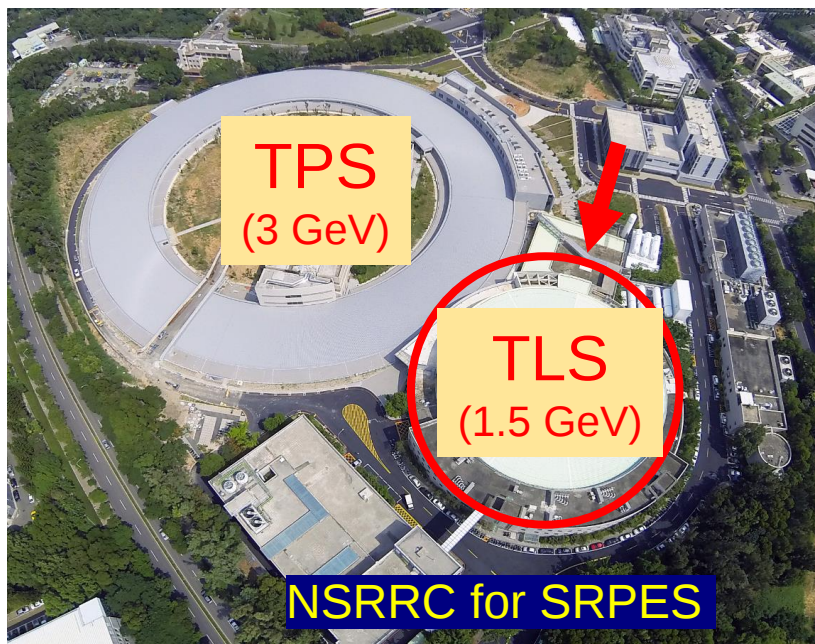
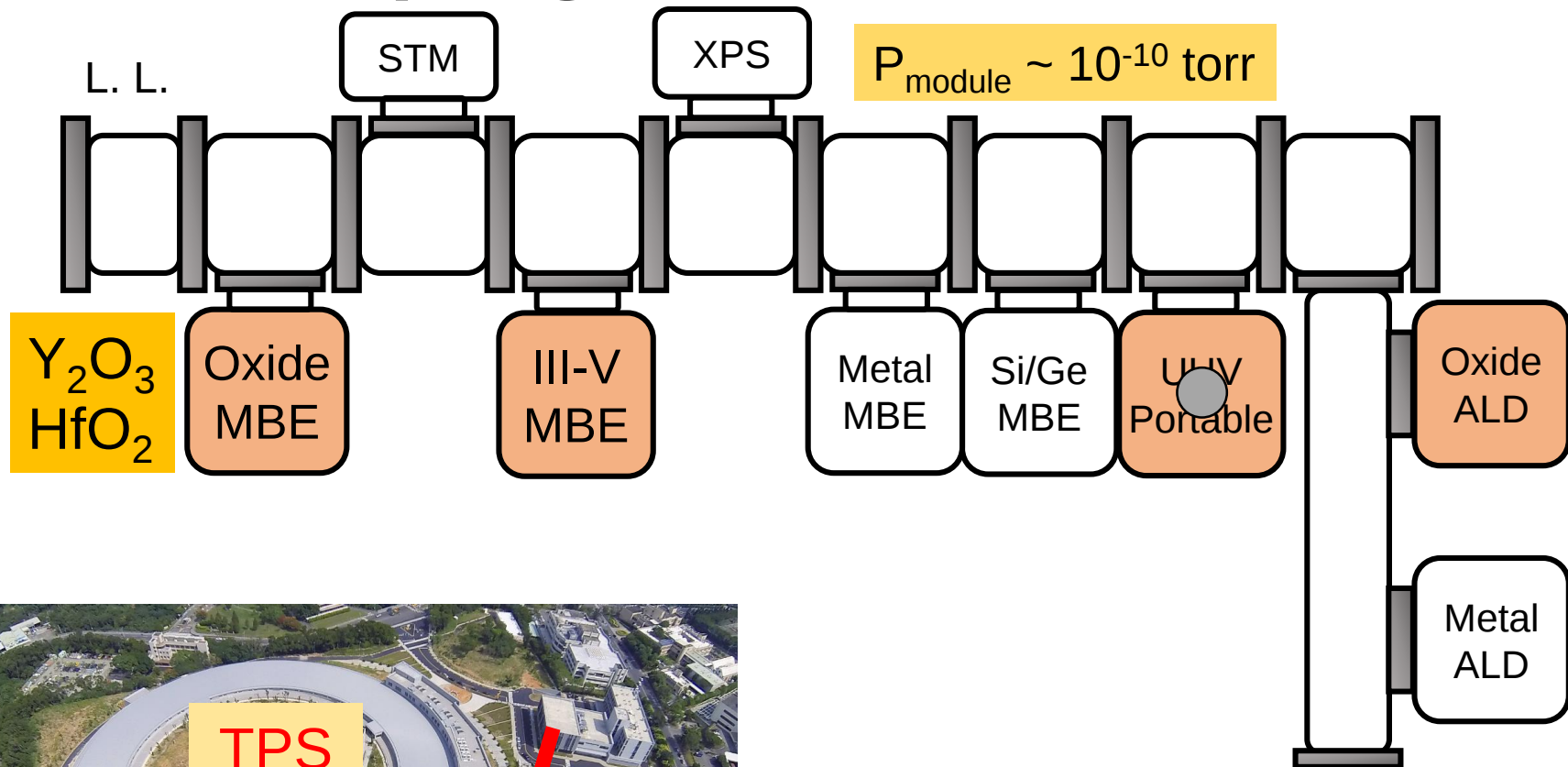
sample growth and transfer



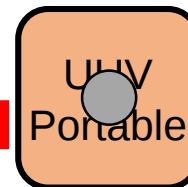
sample growth and transfer



sample growth and transfer

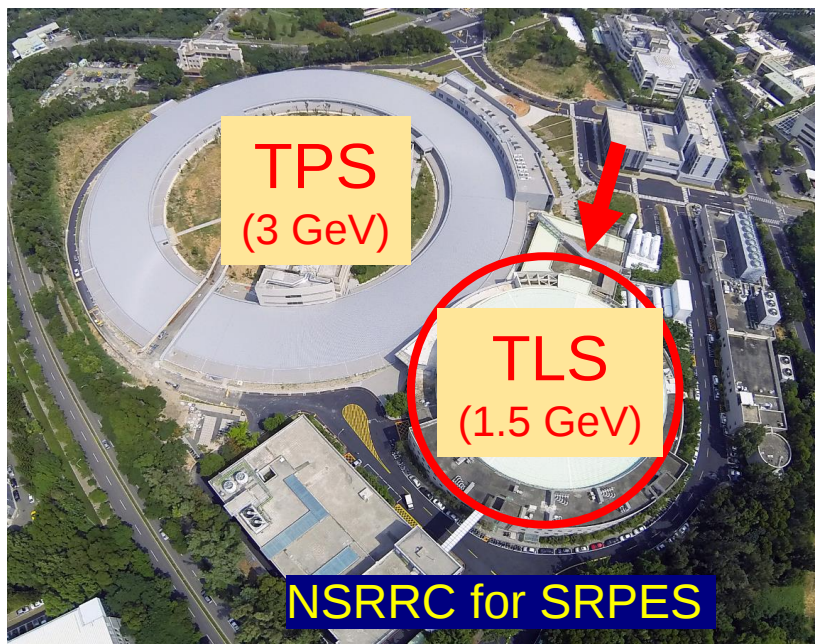
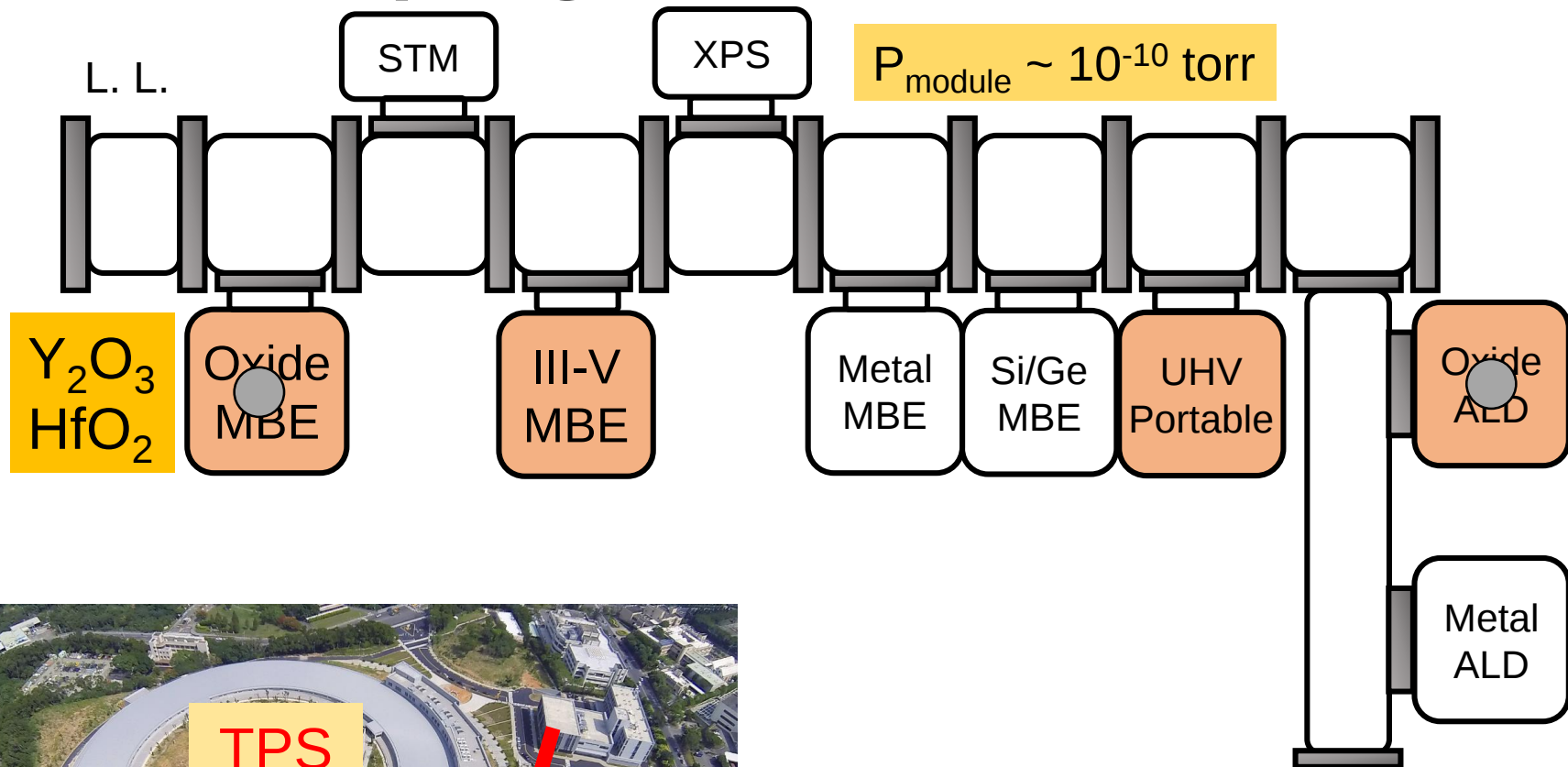


$P \sim 5 \times 10^{-10}$ torr



7 km

sample growth and transfer



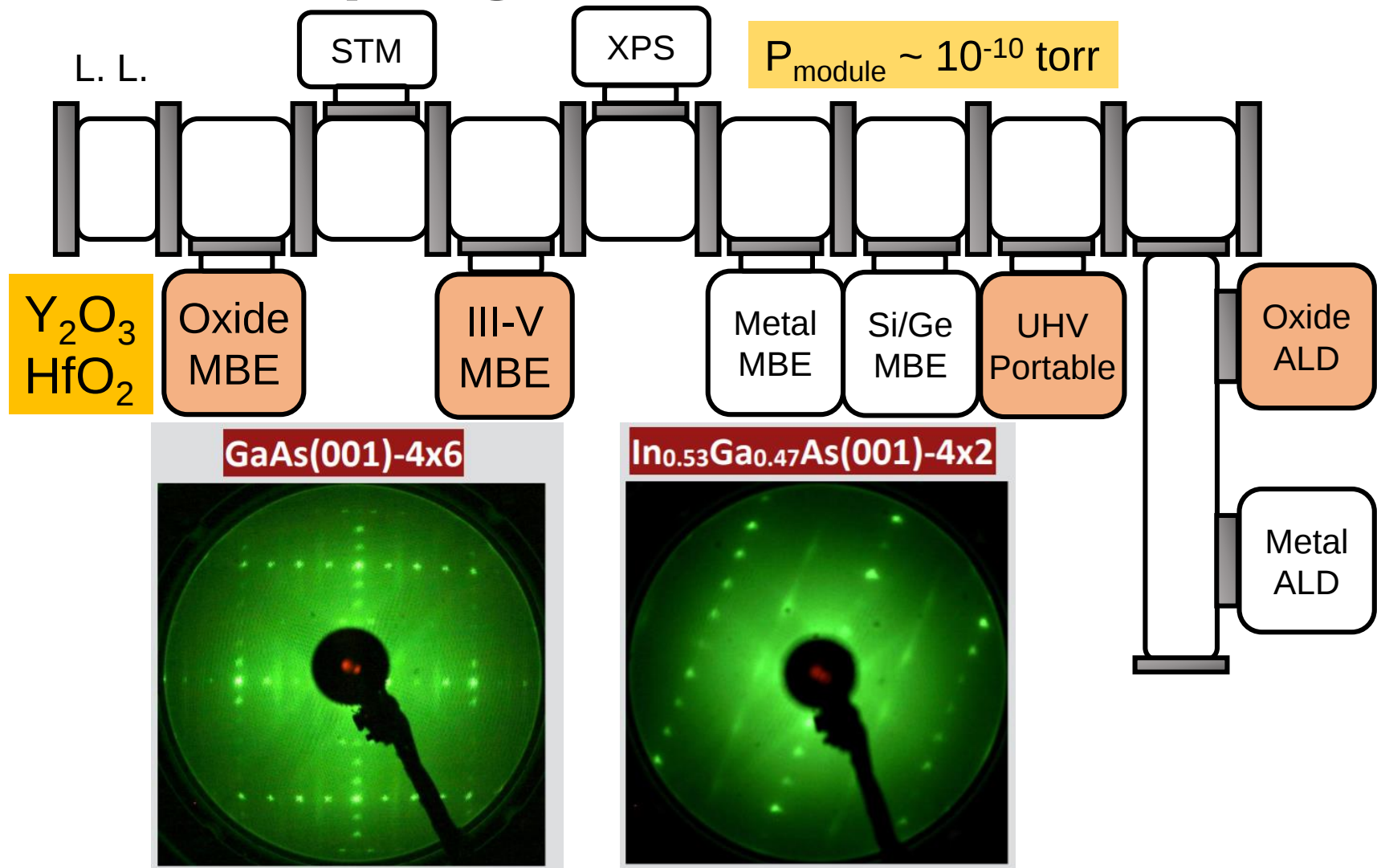
$P \sim 5 \times 10^{-10}$ torr

UHV
Portable

7 km

NSRRC for SRPES

sample growth and transfer



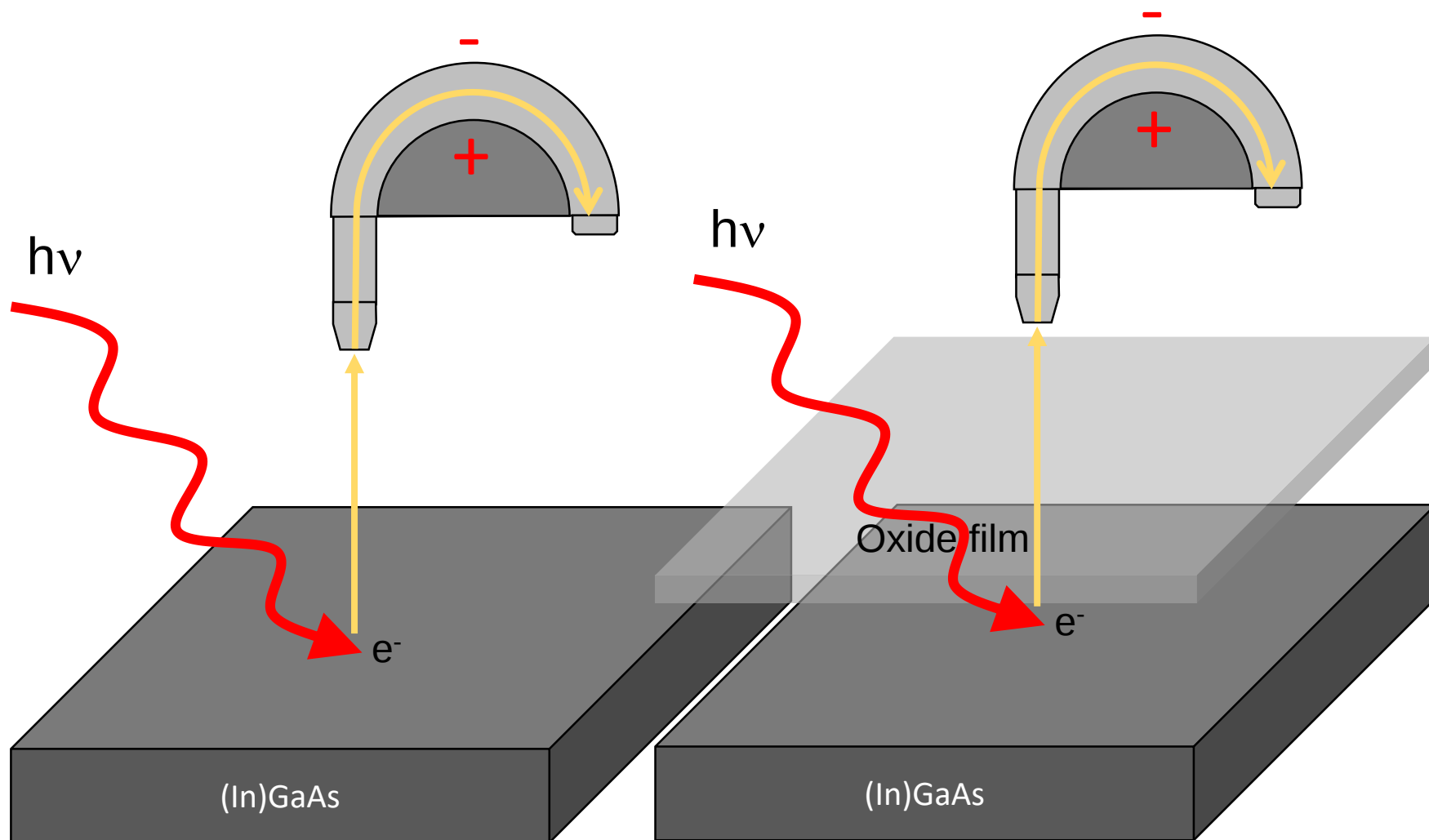
Clear observation of the interfacial evolution for Y_2O_3 / HfO_2 deposited on (In)GaAs.

量測方法

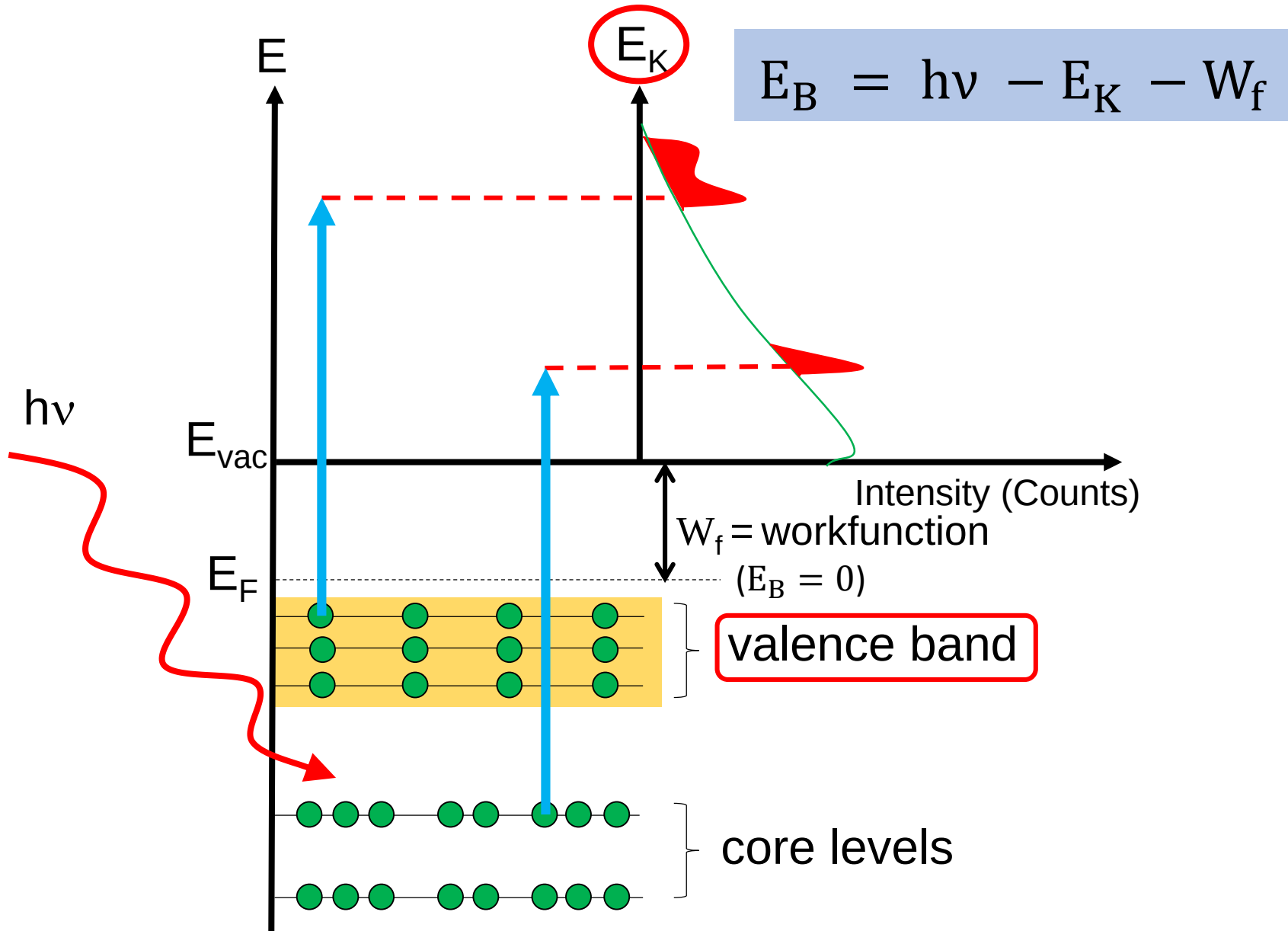
1. Clean (In)GaAs

$P_{\text{base}} = 1 \times 10^{-10}$ torr

2. oxide/(In)GaAs

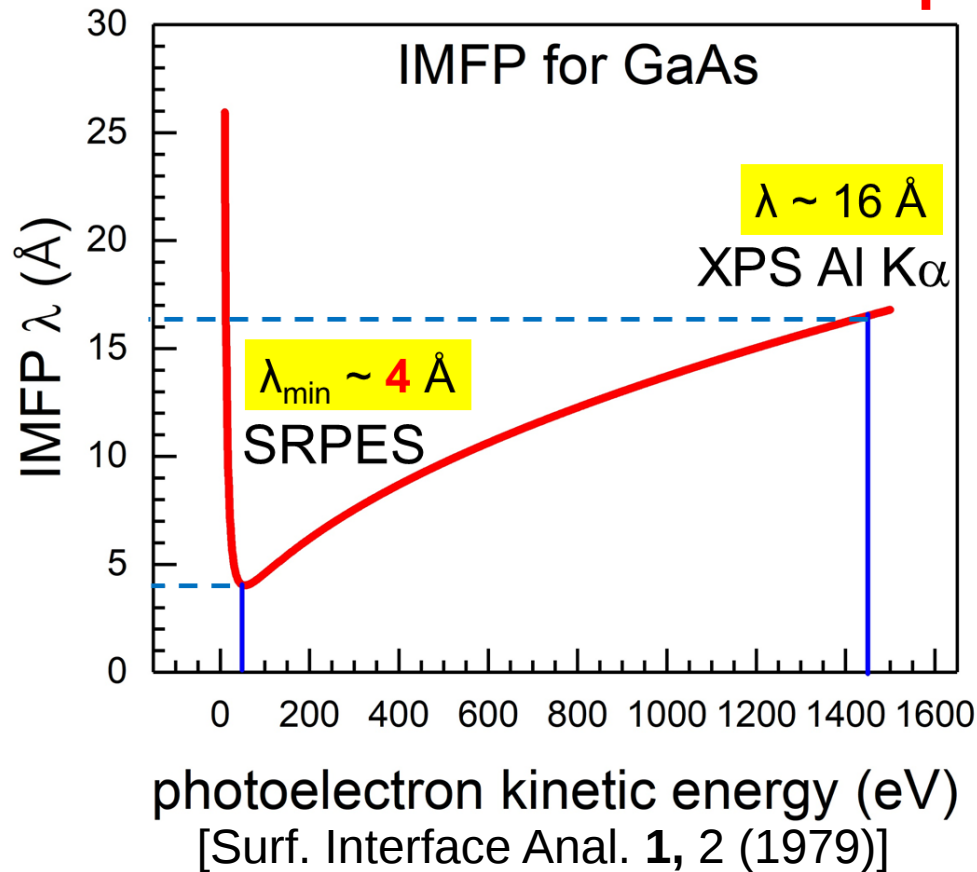


Photoemission



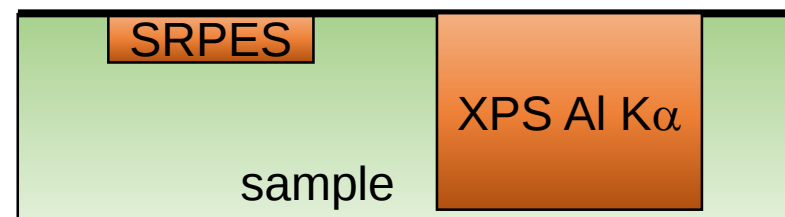
Advantage of synchrotron radiation photoemission

IMFP = inelastic mean free path



Tunable photon energy

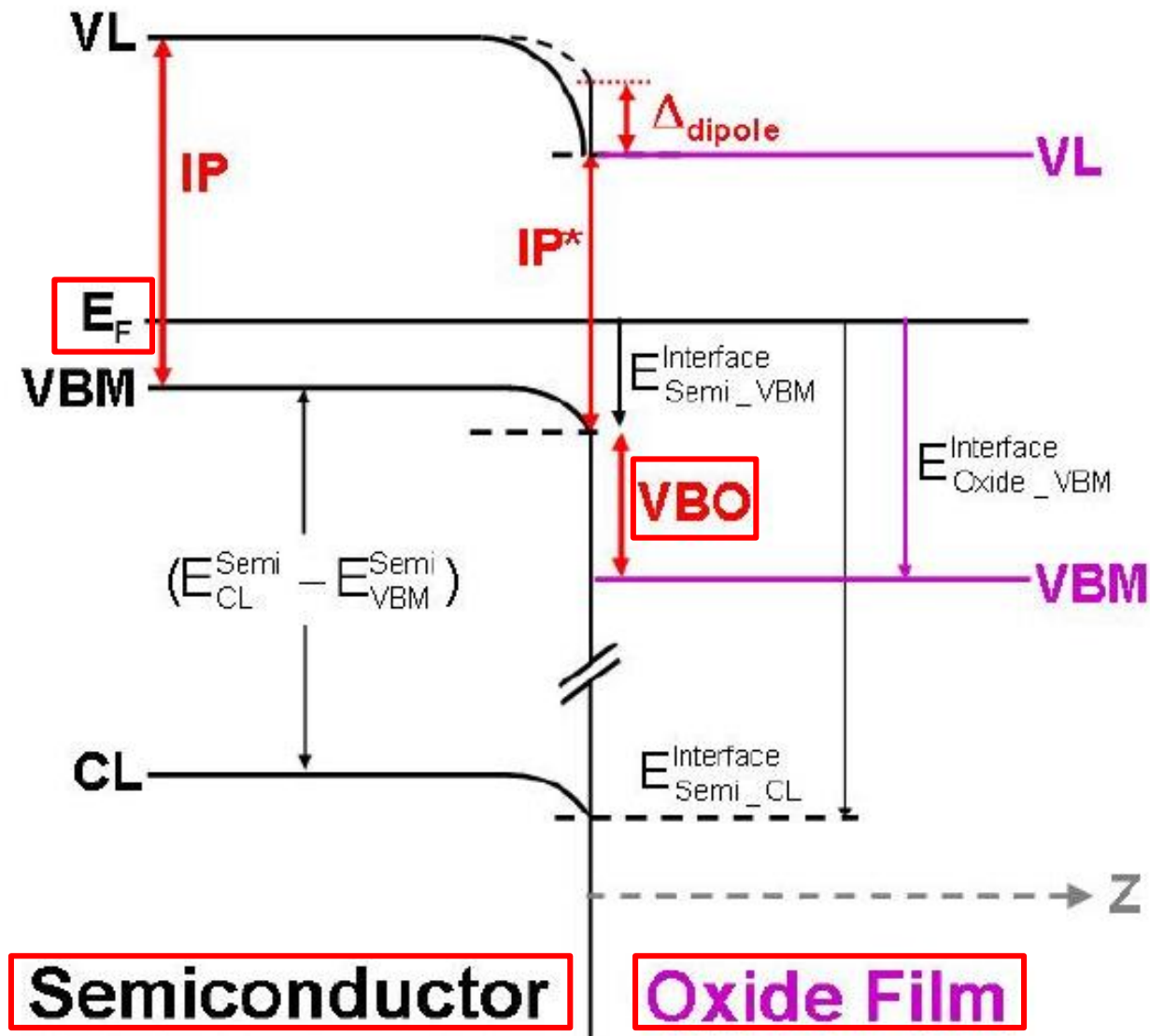
- ✓ high surface sensitivity ($\lambda = 4 \text{ \AA}$)
- ✓ high energy resolution ($< 40 \text{ meV}$)



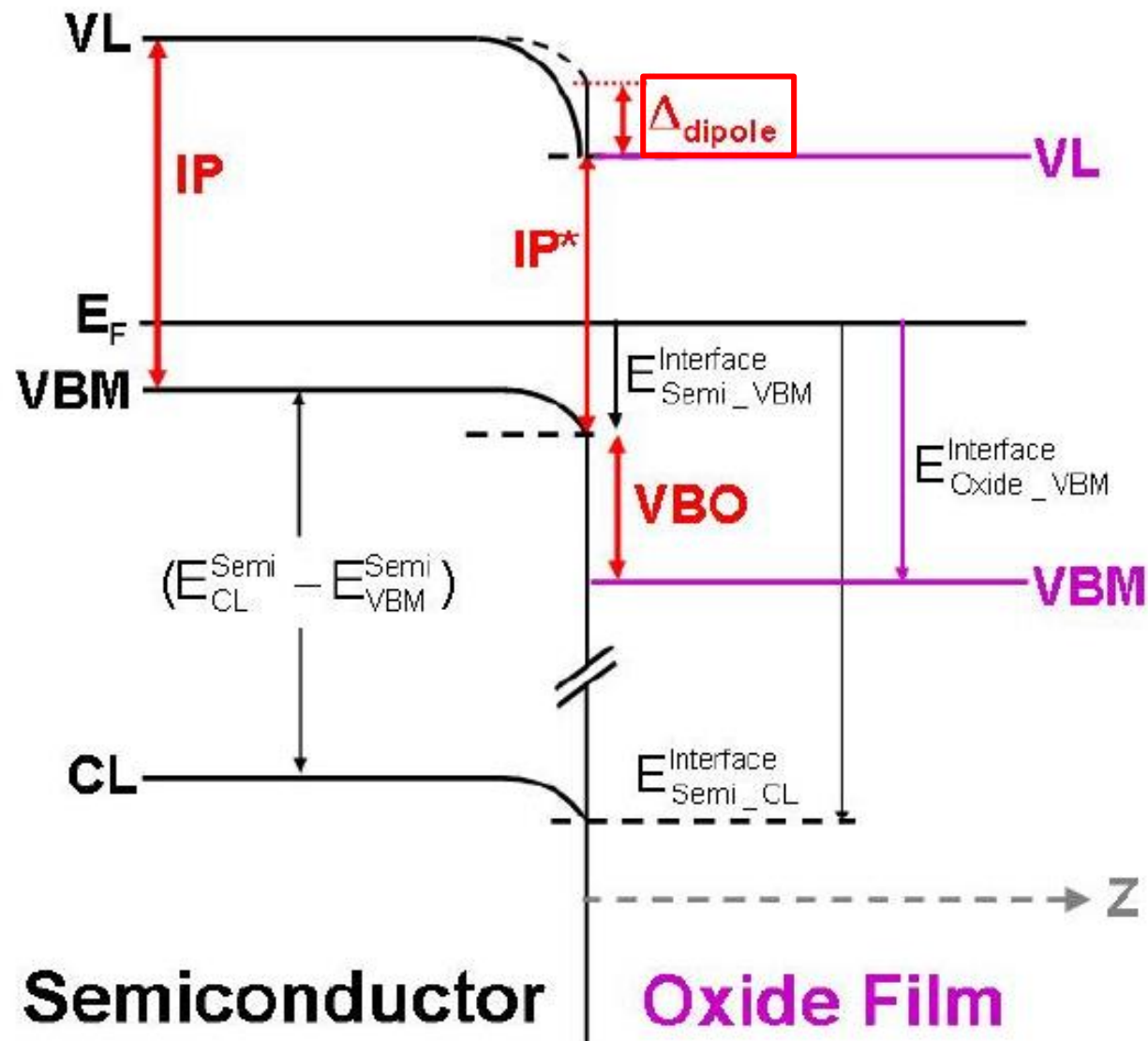
Surface

Probing depth from surface

Band diagram



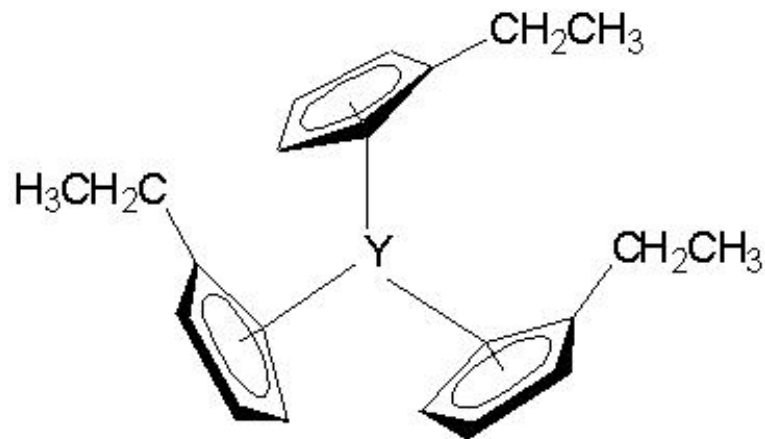
Band diagram



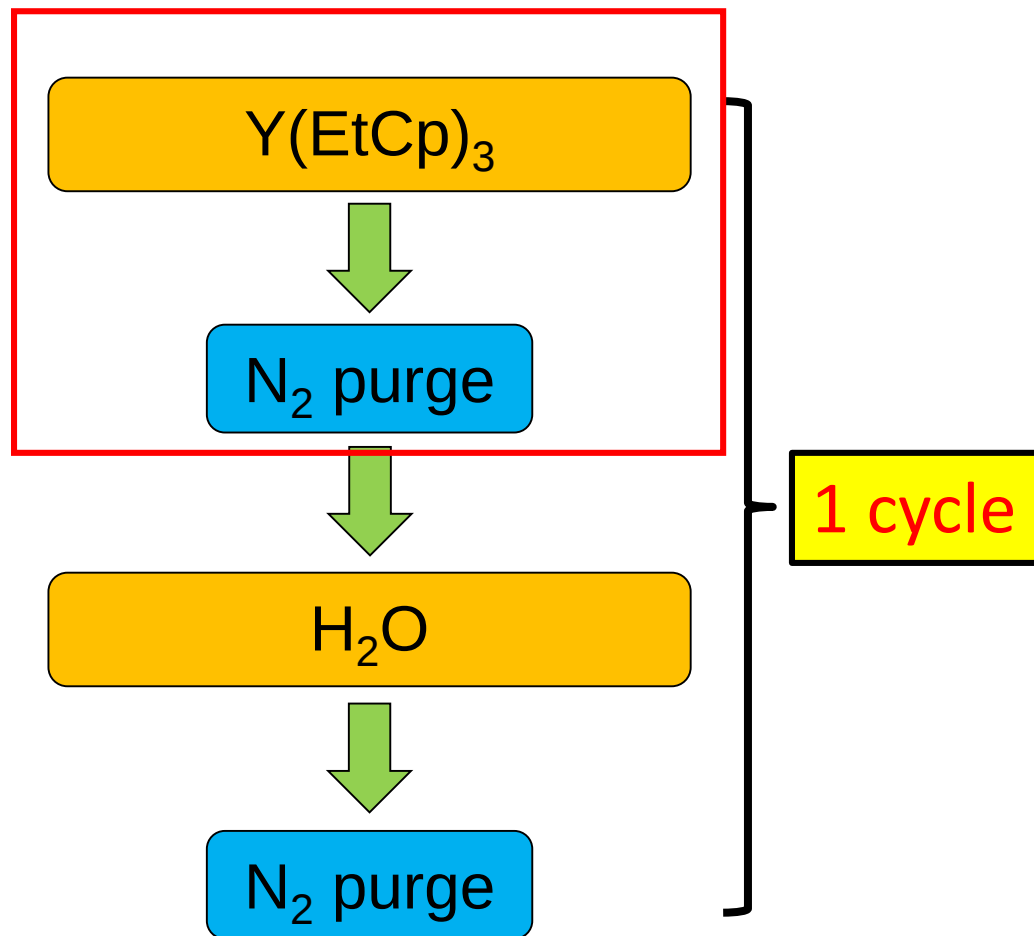
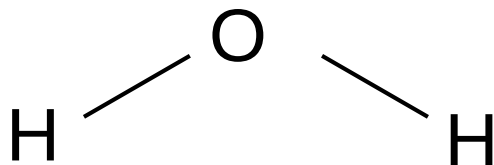
ALD- Y_2O_3 growth

$\text{Y}(\text{EtCp})_3 \rightarrow \text{Tris(ethylcyclopentadienyl)yttrium(III)}$

0.5 cycle

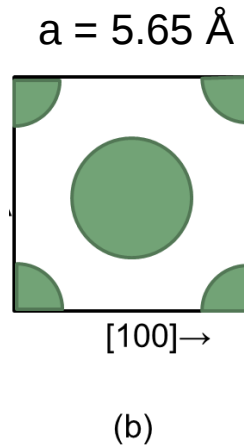
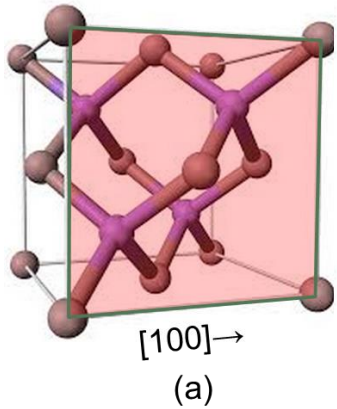


Water (H_2O)



Complete coverage of Y_2O_3 on GaAs(001)

$\theta_{Y_2O_3}$ (Å) with respect to GaAs lattice



4.38 Å Y_2O_3 = complete coverage of GaAs(001)

p-GaAs(001)

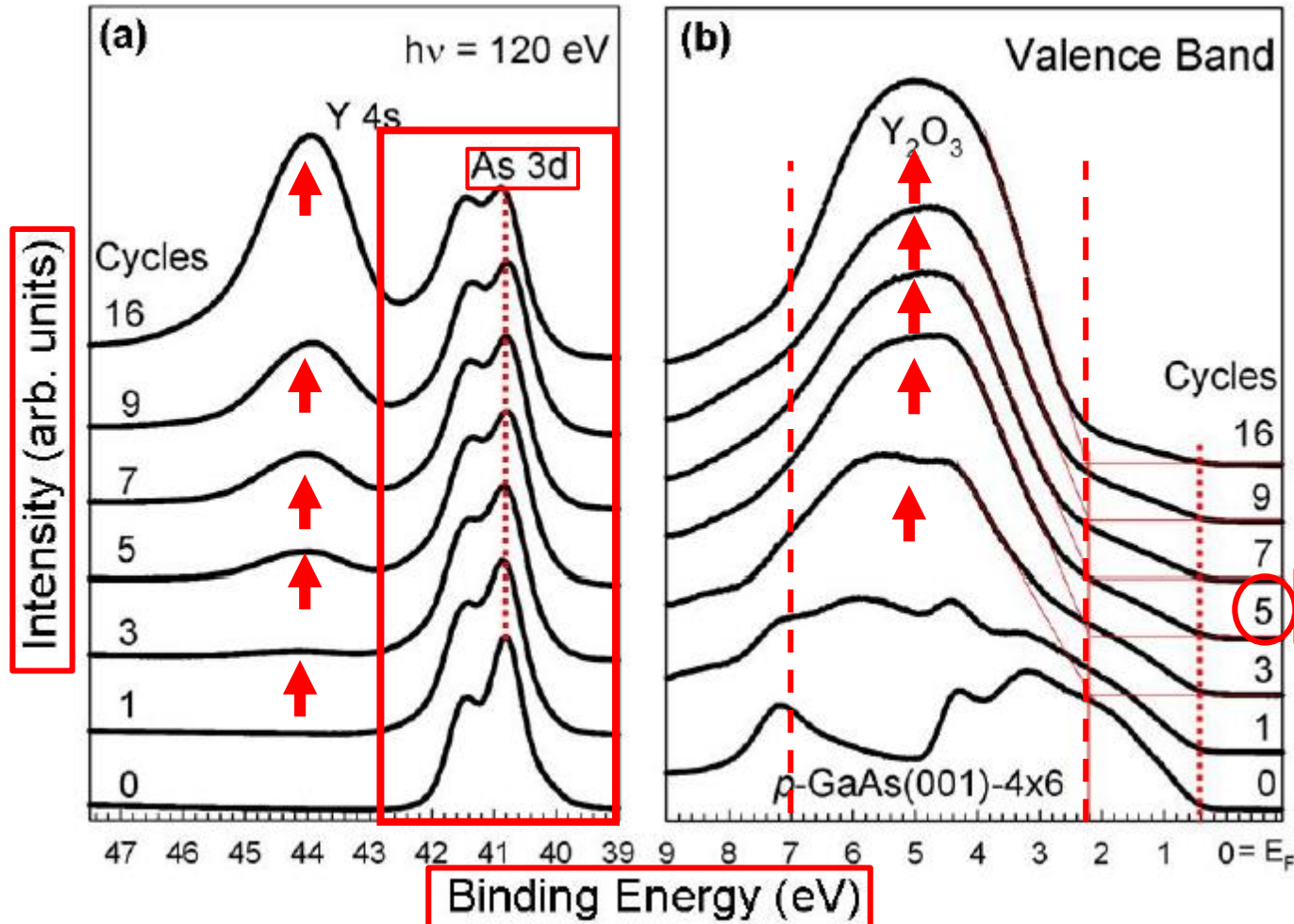
$D_A = \text{surface atomic density of GaAs(001)} = 6.27 \times 10^{14} \text{ atoms/cm}^2$

$D_V = \text{Volume density of } Y_2O_3 = 1.43 \times 10^{22} \text{ atoms/cm}^3$

$$\text{Complete coverage} = \frac{D_A}{D_V} = \frac{6.27 \times 10^{14} \text{ atoms/cm}^2}{1.43 \times 10^{22} \text{ atoms/cm}^3} = 4.38 \text{ Å}$$

SRPES results

No band bending



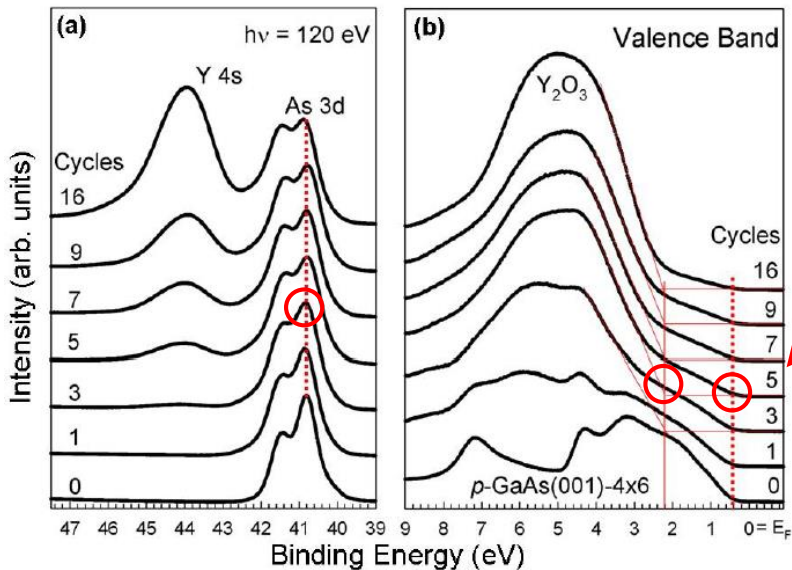
Complete Y_2O_3
coverage = 4.38 Å

5 cycles ~ 4.59 Å

Complete coverage
 $V_{BM_{Y_2O_3}} = 2.2$ eV

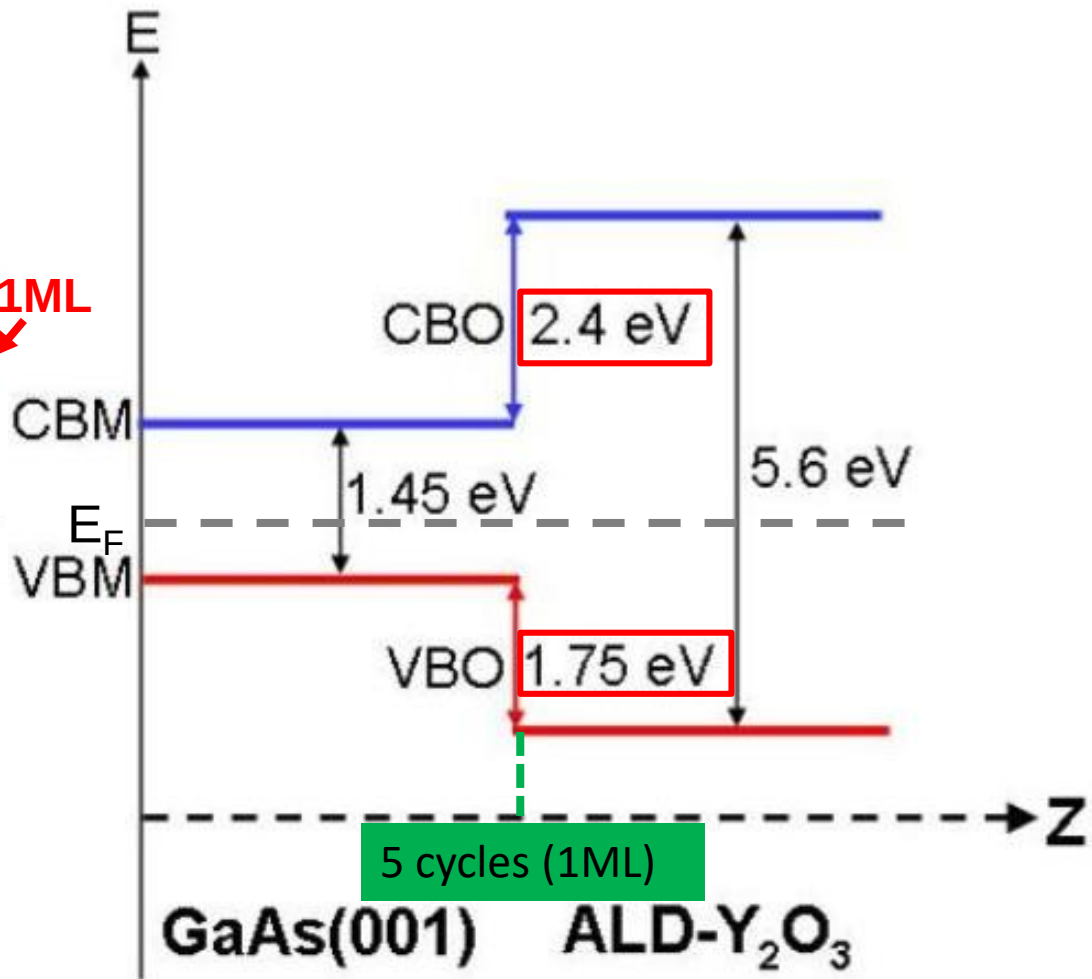
$V_{BM_{GaAs}} = 0.45$ eV

Band diagram



$$\text{VBM}_{\text{GaAs}} = 0.45 \text{ eV}$$

$$\text{VBM}_{\text{Y}_2\text{O}_3} = 2.2 \text{ eV}$$

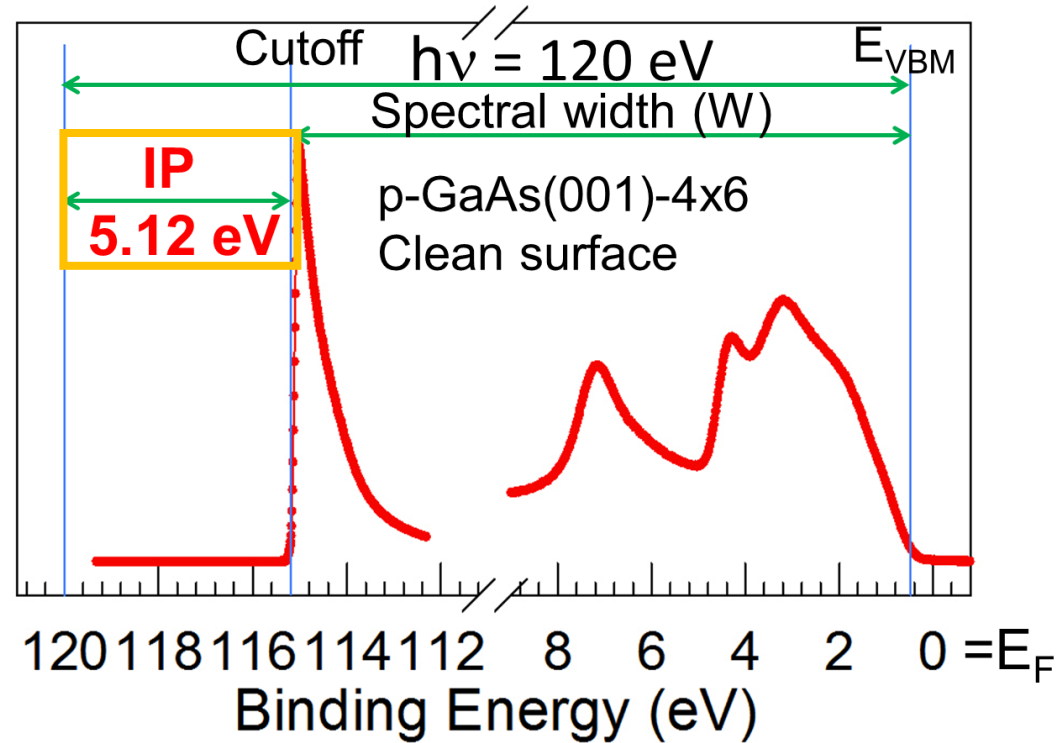
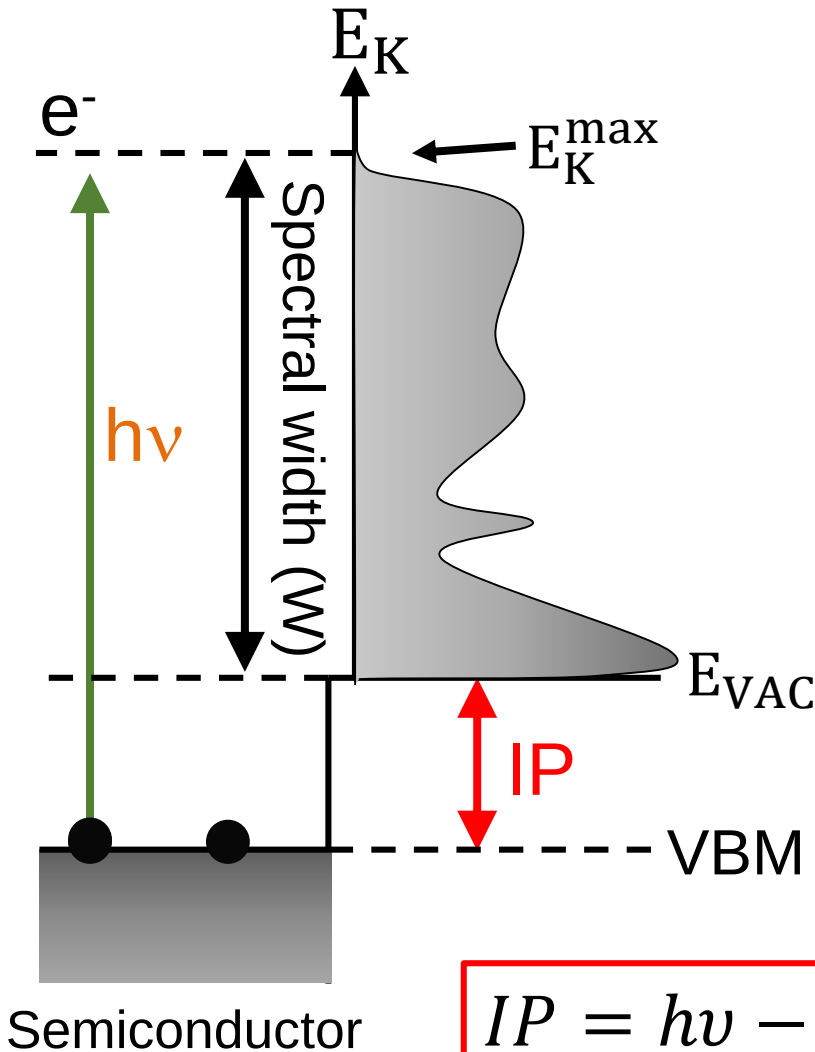


We can obtain the band offset of 1 ML oxide film on semiconductor

Interfacial dipole potential energy

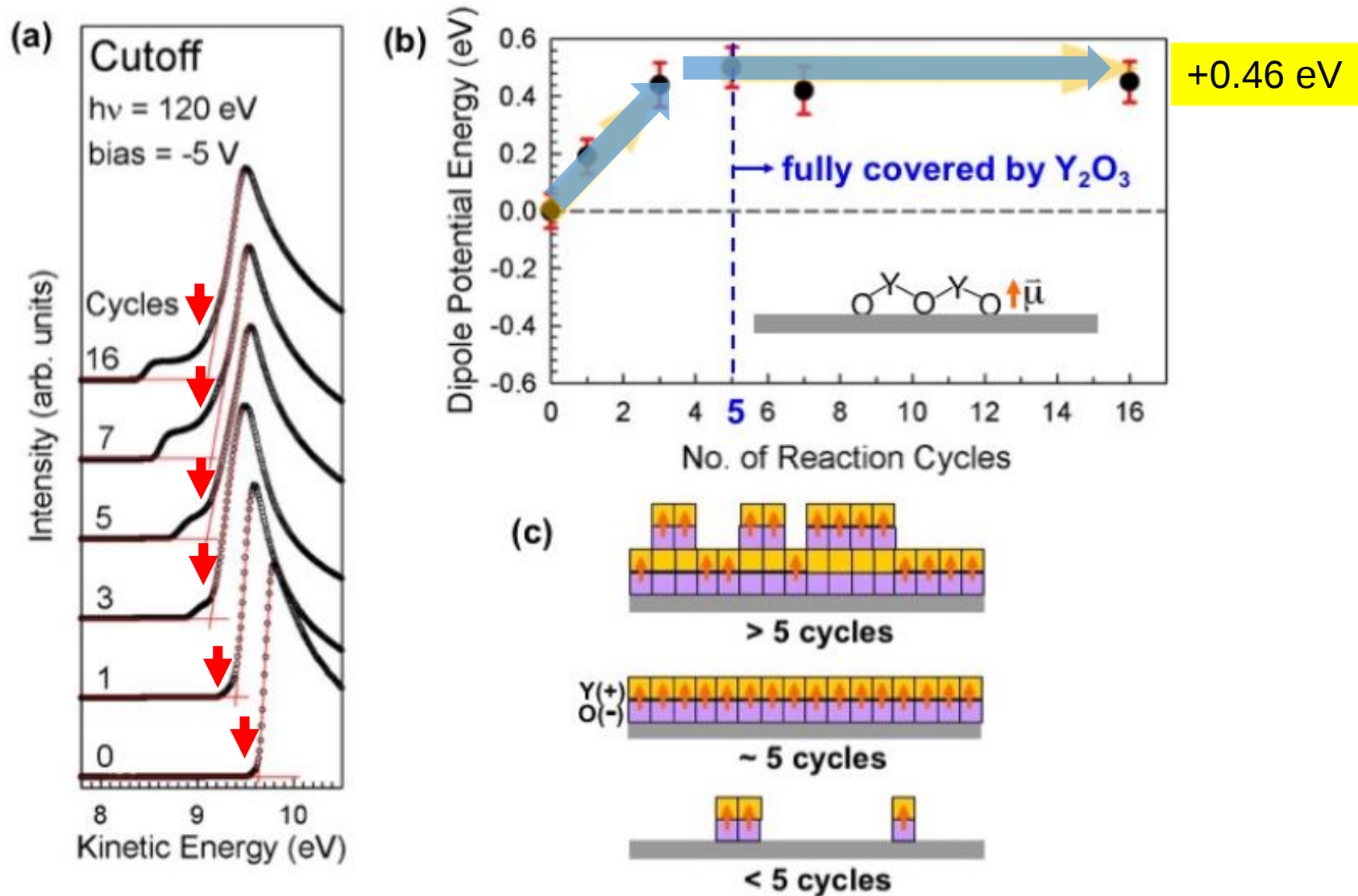
$$\begin{array}{l} \text{Interfacial dipole potential energy} \\ \equiv \text{IP}_{\text{clean}} - \text{IP}_{\text{adsorbate}} \end{array} \begin{array}{c} + \\ \uparrow \\ - \end{array}$$

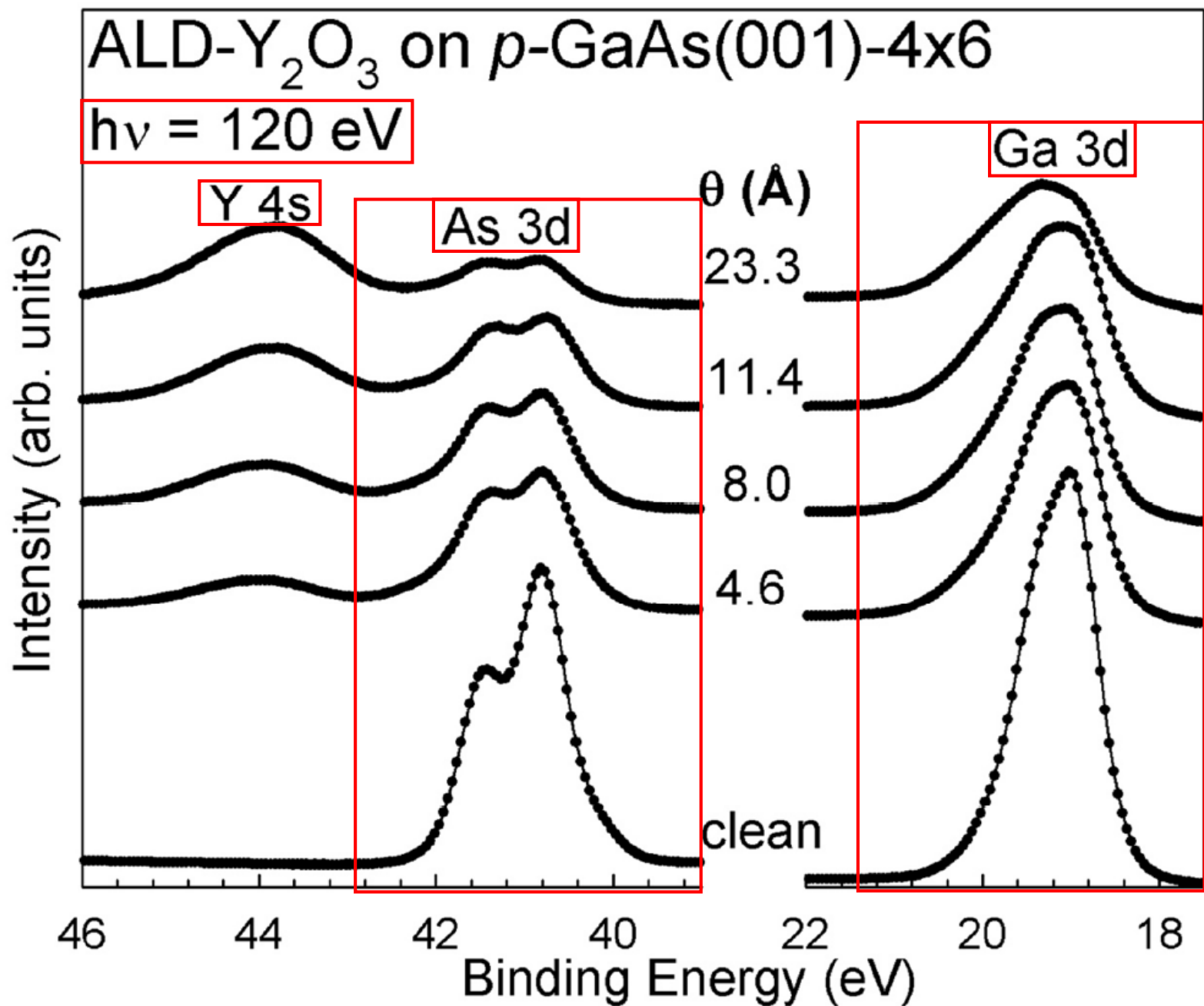
Determination of ionization potential energy



$$\begin{aligned}
 IP &= h\nu - W \\
 &= h\nu - (\text{cutoff} - \text{VBM})
 \end{aligned}$$

Interfacial dipole potential energy



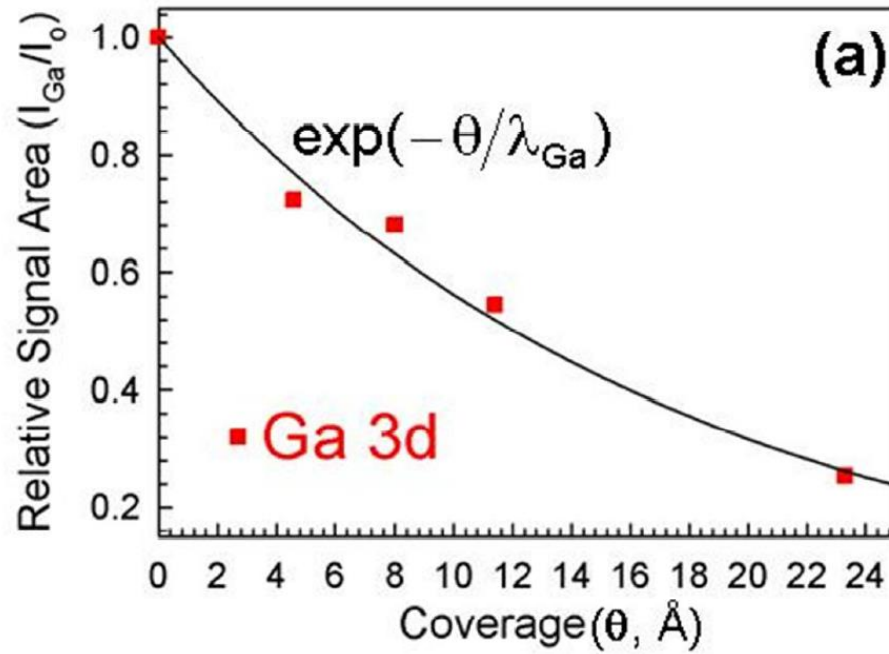


Growth mode

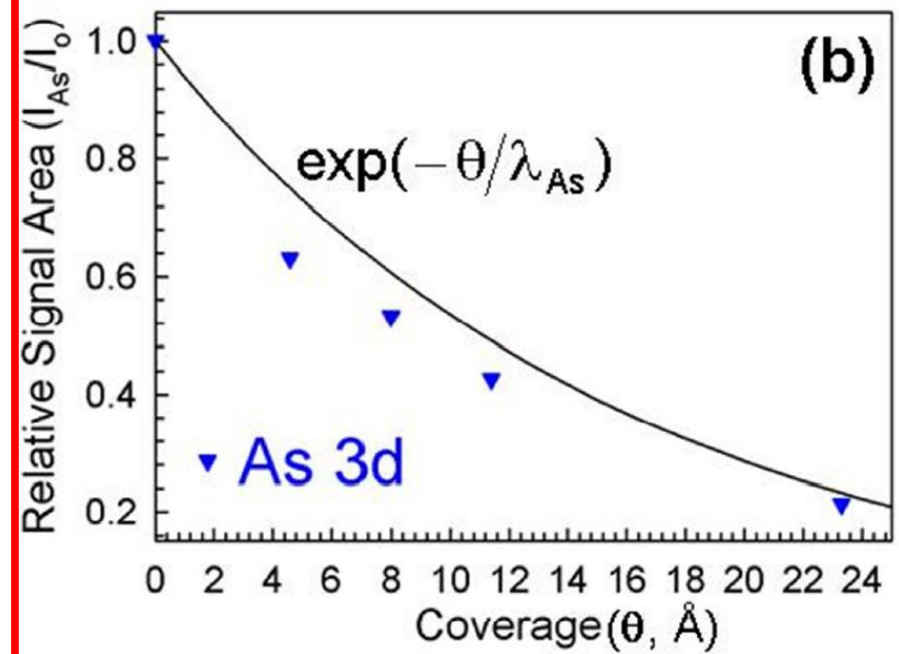
Ideal curve :

$$\frac{I_{\theta}}{I_0} = e^{-\theta/\lambda}$$

Ga 3d



As 3d



Growth mode

$$I = I_0 e^{-\theta/\lambda}$$

Ideal curve

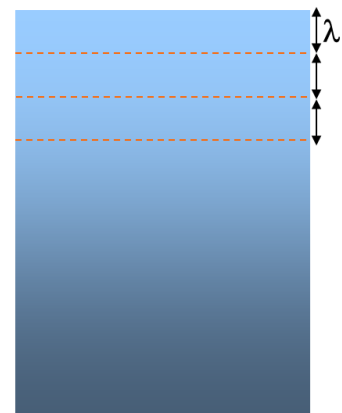
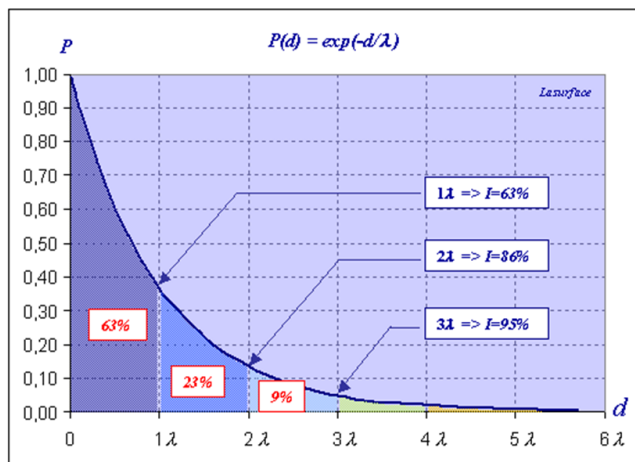
$$d_0 = 2.83 \text{ \AA}$$

$$\lambda_0 = 10.41 \text{ \AA}$$

$$I_0 = I_s \frac{1}{\left(1 - e^{-d_0/\lambda_0}\right)}$$

Total intensity of clean GaAs

$$(I_0 = I_s + I_s e^{-d_0/\lambda_0} + I_s e^{-2 d_0/\lambda_0} + \dots)$$



⇒ ~ 95% photoelectrons emission from within 3λ below the surface

Growth mode

$$I = I_0 e^{-\theta/\lambda}$$

Ideal curve

$$I_0 = I_s \frac{1}{(1 - e^{-d_0/\lambda_0})}$$

Total intensity of clean GaAs

$$I = (I_0 - x * I_s) e^{-\theta/\lambda}$$

Assume that x percentage of the surface atoms is removed

$$\frac{I_{As}}{I_{Ga}} = \frac{(I_{0,As} - x * I_{s,As}) e^{-\theta/\lambda_{As}}}{I_{0,Ga} e^{-\theta/\lambda_{Ga}}}$$

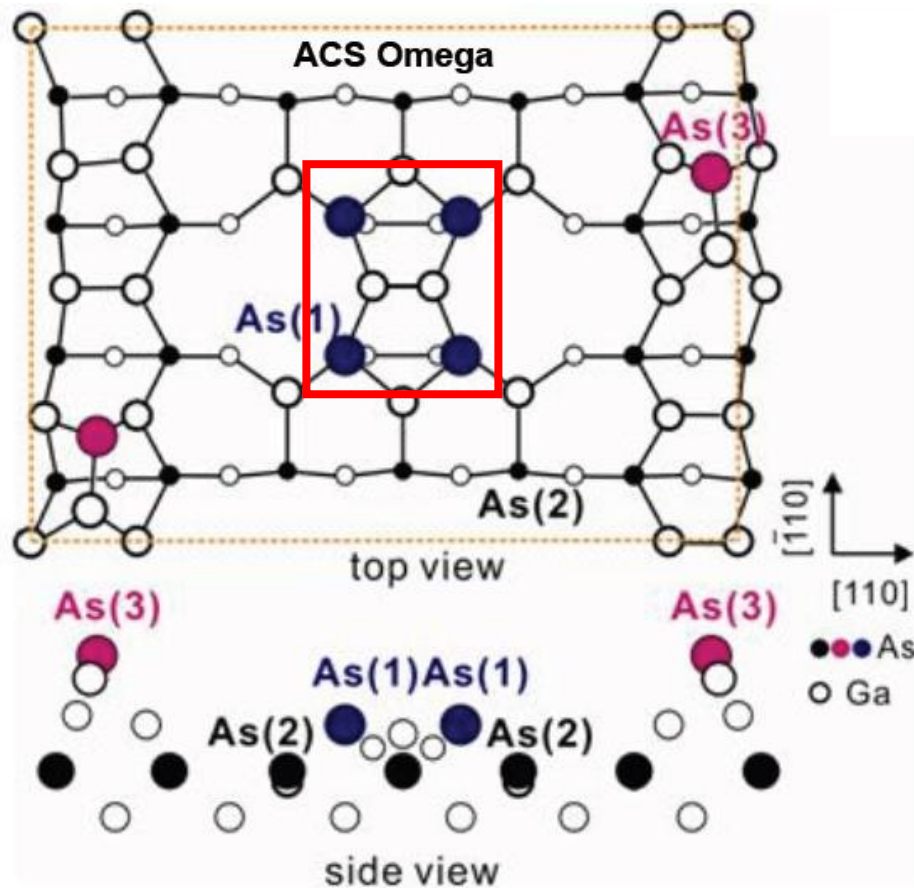
$$\frac{I_{0,As}}{I_{0,Ga}} = 0.53$$

$$\frac{I_{As}}{I_{Ga}}(23\text{\AA}) = 0.45 \text{ \AA}$$

$$x \sim 18\%$$

Growth mode

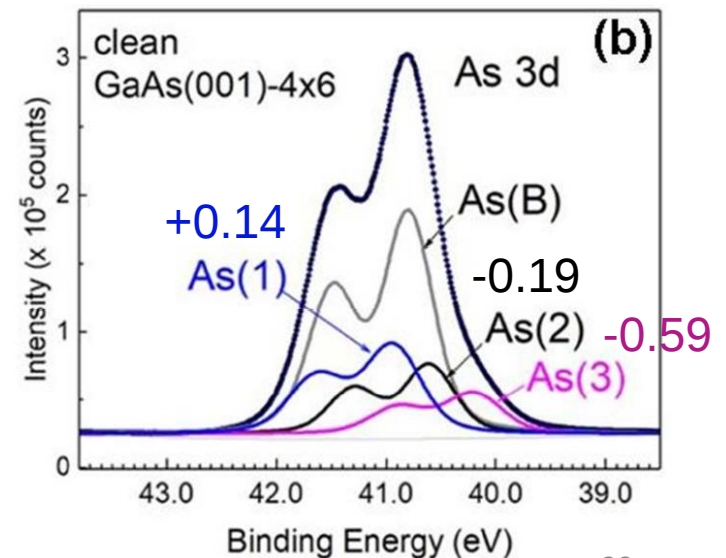
GaAs(001)-4x6 *Theoretical calculation* → $x \sim 18\%$



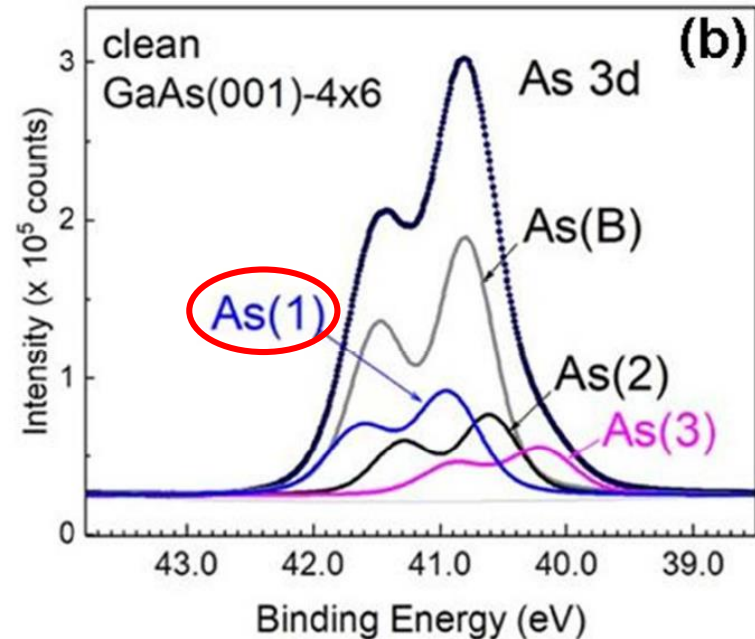
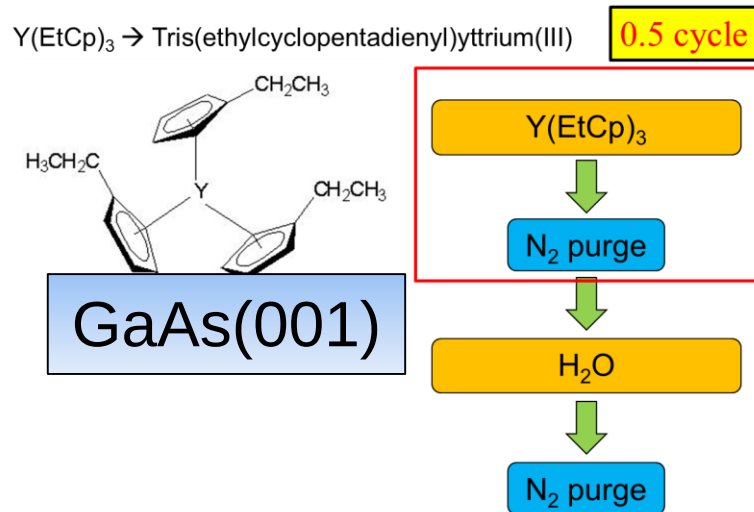
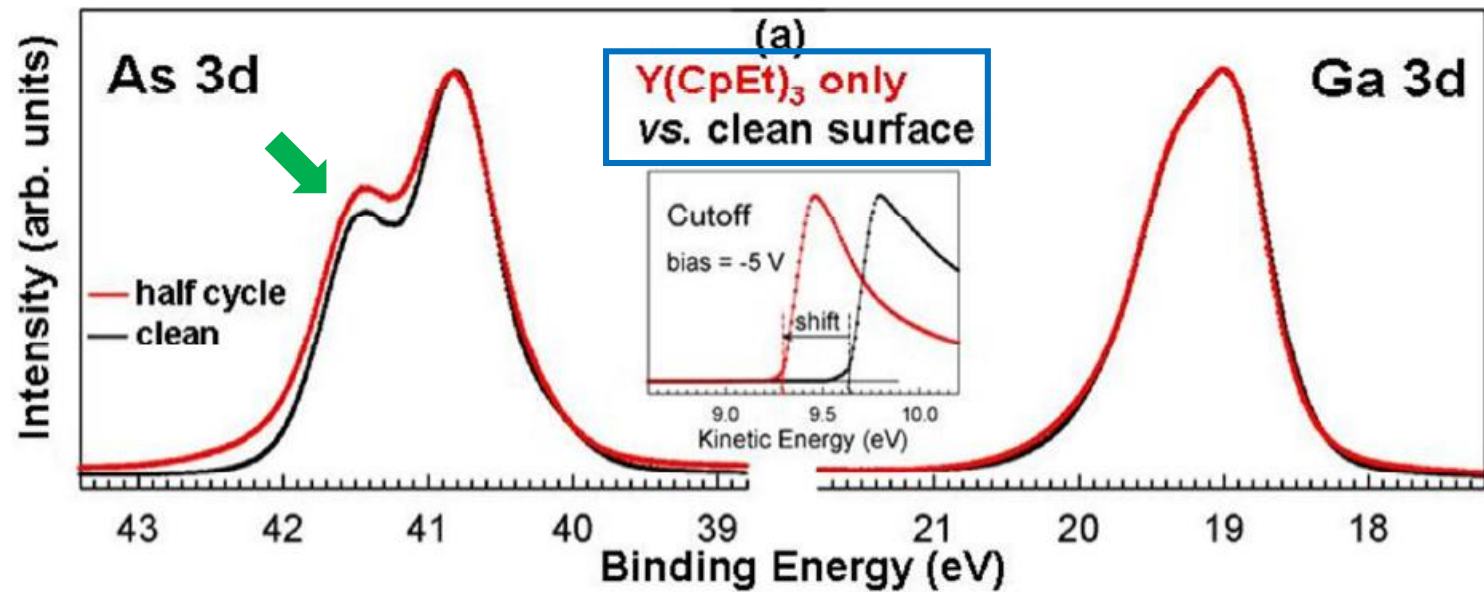
As(1) : 17%

As(2) : 25%

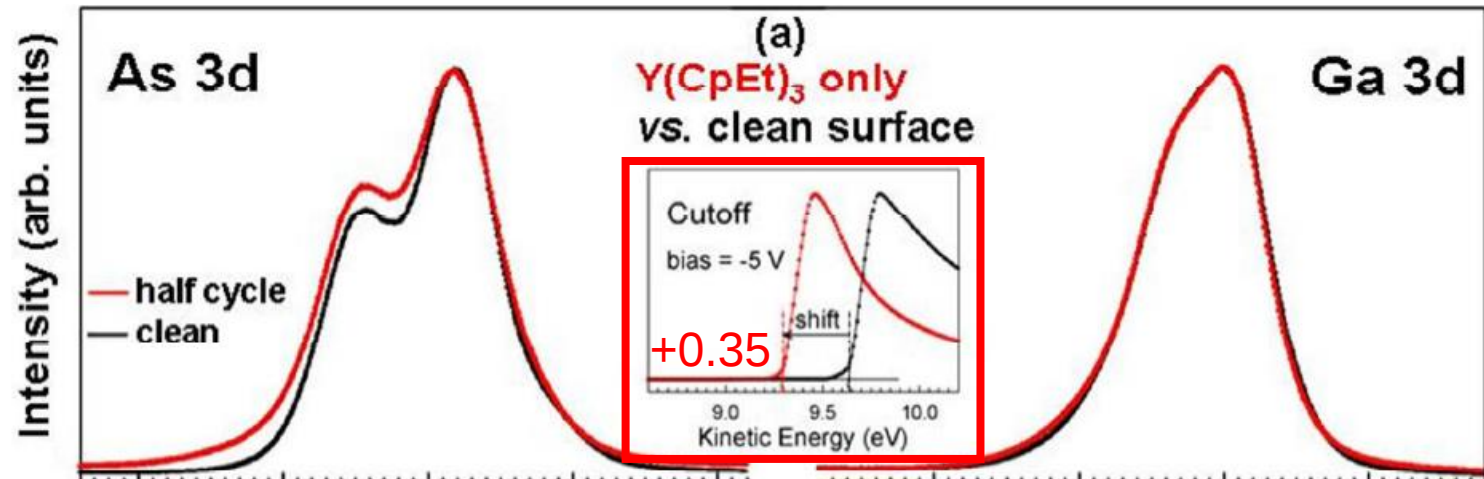
As(3) : 8%



Atom-to-atom interaction

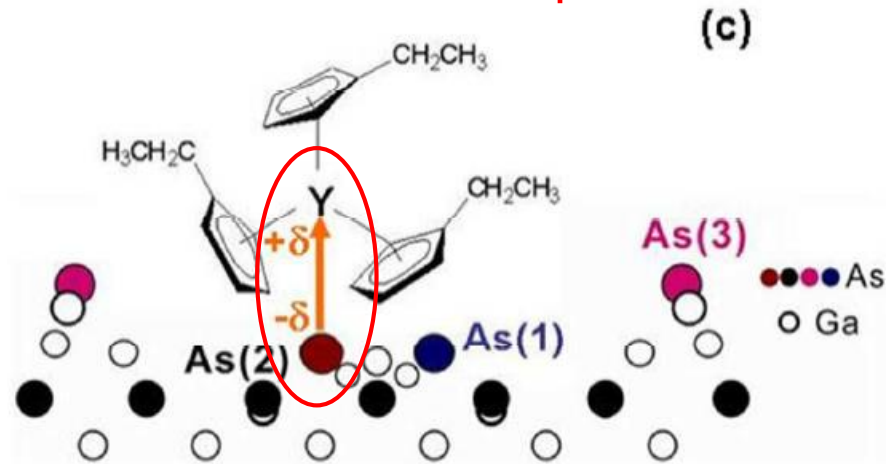
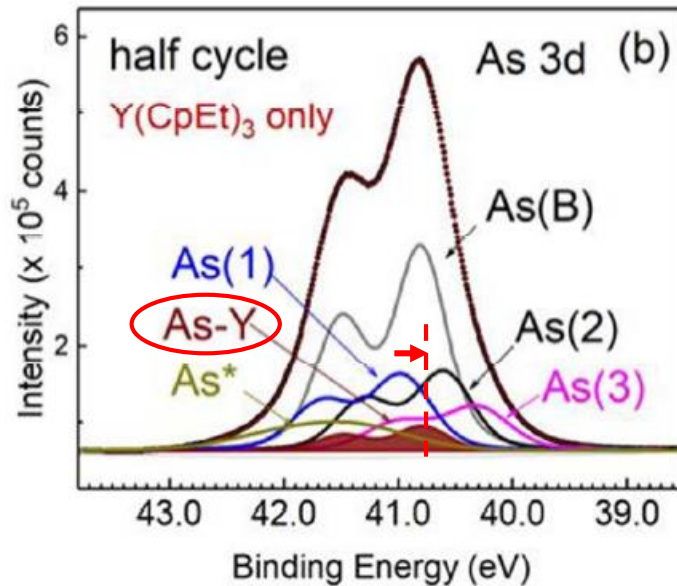


Atom-to-atom interaction

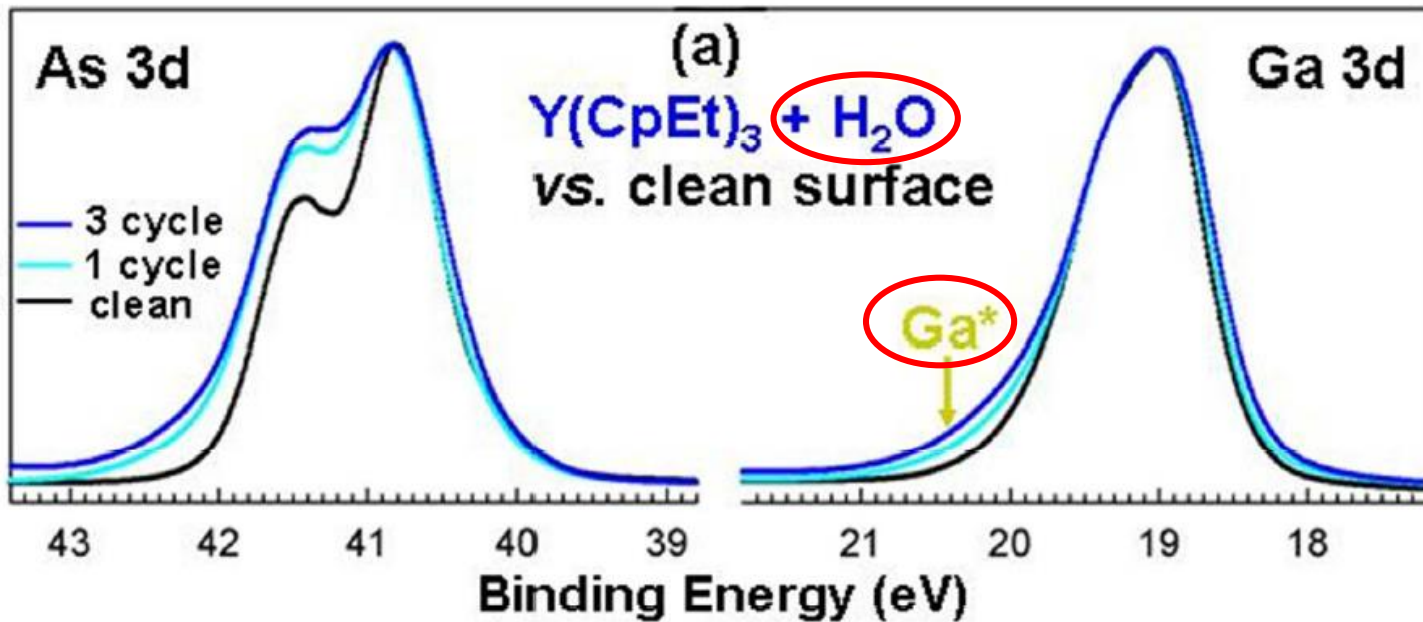
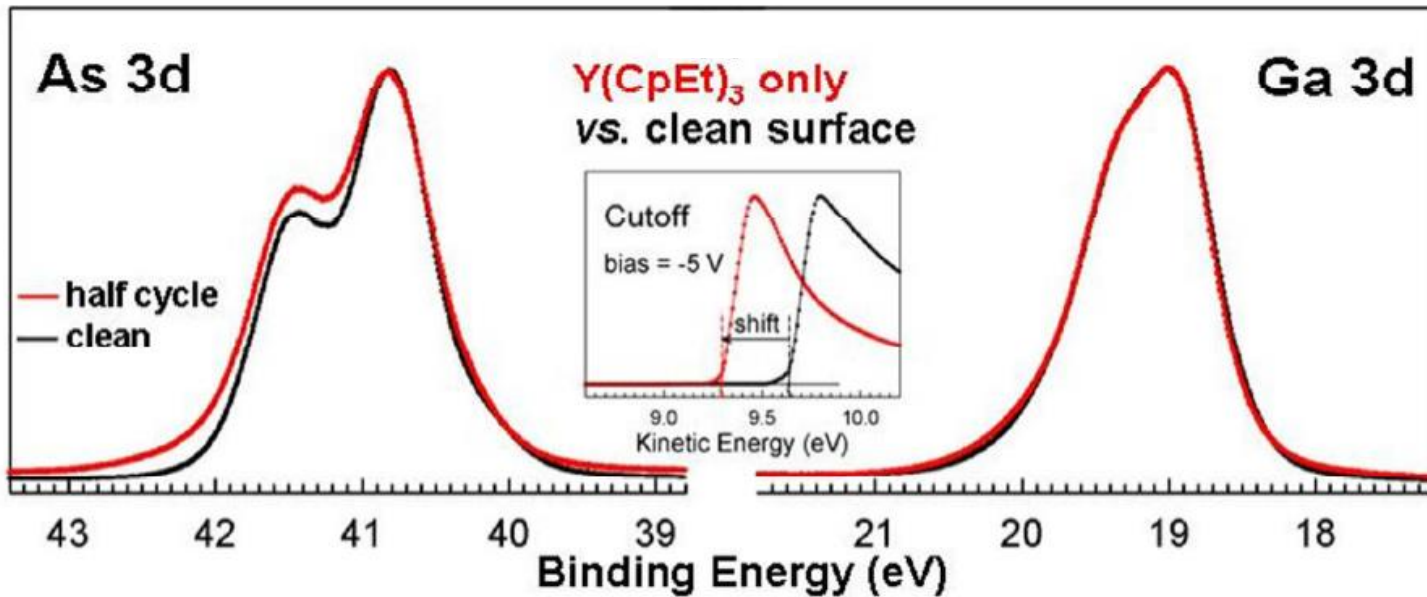


$$\text{Interfacial dipole potential energy} = IP_{\text{GaAs}} - IP_{\text{Y}_2\text{O}_3/\text{GaAs}}$$

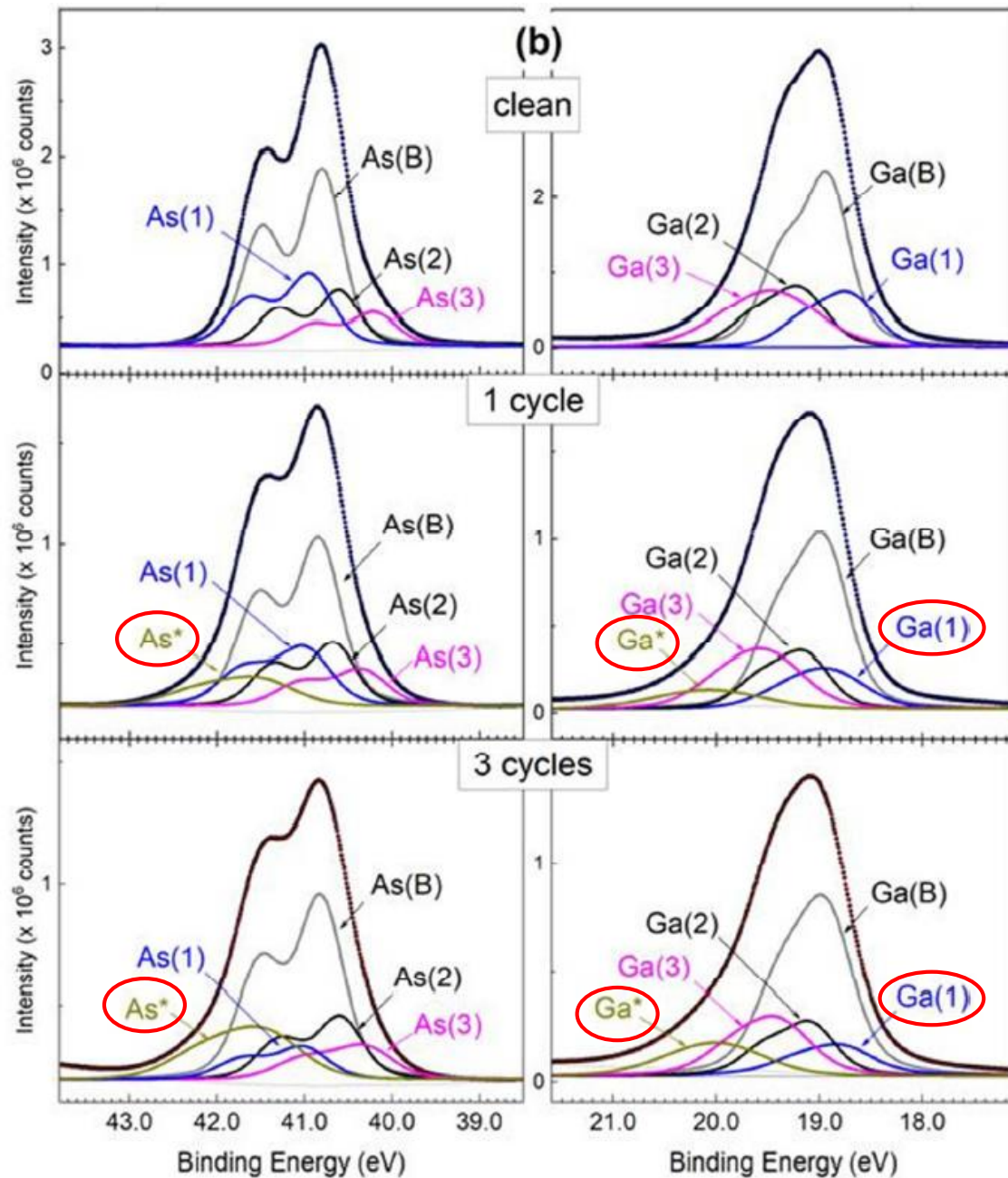
Not a polar molecule



Atom-to-atom interaction



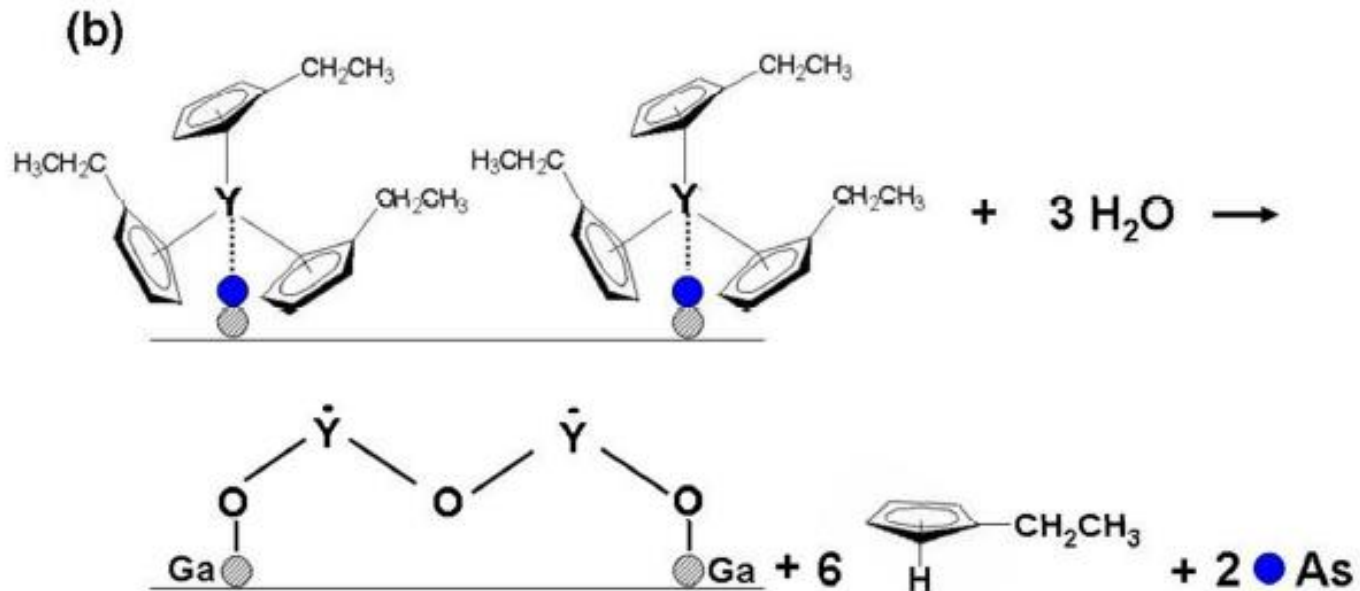
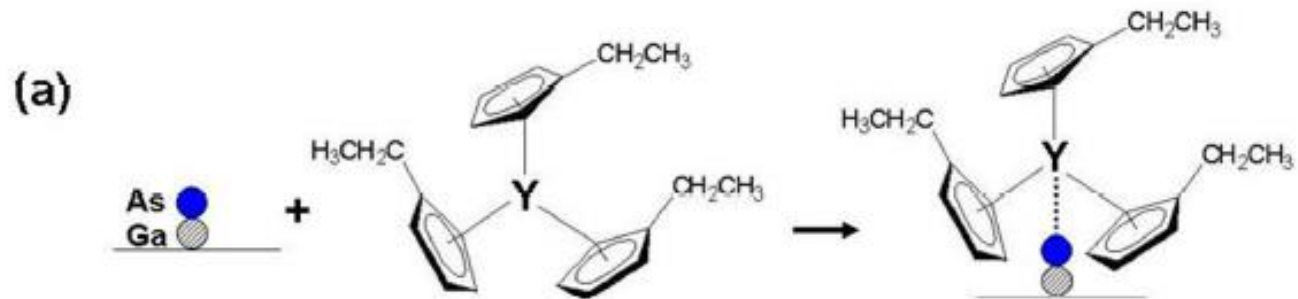
Atom-to-atom interaction



As* = As atom

Ga* = Ga₂O

ALD $\text{Y}_2\text{O}_3/\text{GaAs}(001)$ -4x6



Atomic Nature of the Growth Mechanism of Atomic Layer Deposited High- κ Y_2O_3 on $\text{GaAs}(001)\text{-}4 \times 6$ Based on in Situ Synchrotron Radiation Photoelectron Spectroscopy

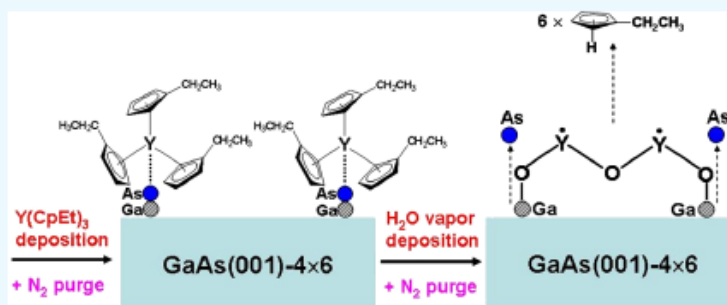
Chiu-Ping Cheng^{*,†,‡} Wan-Sin Chen,[‡] Yi-Ting Cheng,[‡] Hsien-Wen Wan,[‡] Cheng-Yeh Yang,[§] Tun-Wen Pi,^{*,||} Jueinai Kwo,^{*,§} and Minghwei Hong^{*,‡}

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[‡]Graduate Institute of Applied Physics and Department of Physics, National Taiwan University, Taipei 10617, Taiwan, ROC

[§]Department of Physics, National Tsing Hua University, Hsinchu 30013, Taiwan, ROC

^{||}National Synchrotron Radiation Research Center, Hsinchu 30076, Taiwan, ROC



ABSTRACT: Y_2O_3 was in situ deposited on a freshly grown molecular beam epitaxy $\text{GaAs}(001)\text{-}4 \times 6$ surface by atomic layer deposition (ALD). In situ synchrotron radiation photoemission was used to study the mechanism of the tris-(ethylcyclopentadienyl)yttrium $[\text{Y}(\text{CpEt})_3]$ and H_2O process. The exponential attenuation of Ga 3d photoelectrons confirmed the laminar growth of ALD- Y_2O_3 . In the embryo stage of the first ALD half-cycle with only $\text{Y}(\text{CpEt})_3$, the precursors reside on the faulted As atoms and undergo a charge transfer to the bonded As atoms. The subsequent ALD half-cycle of H_2O molecules removes the bonded As atoms, and the oxygen atoms bond with the underneath Ga atoms. The product of a line of Ga–O–Y bonds stabilizes the Y_2O_3 films on the GaAs substrate. The resulting coordinatively unsaturated Y–O pairs of Y_2O_3 open the next ALD series. The absence of Ga_2O_3 , As_2O_3 , and As_2O_5 states may play an important role in the attainment of low interfacial trap densities (D_{it}) of $<10^{12} \text{ cm}^{-2} \text{ eV}^{-1}$ in our established reports.

Summary

- Our unique approach of combining MBE/ALD with SRPES *in-situ* is a must to characterize interfacial chemistry for high-k/(In)GaAs hetero-structures.
- High surface sensitivity and high energy resolution of SRPES enable an atomic-scale interface study down to atom-to-atom interaction.

Thank You